TPS717xx 低噪声、高带宽 PSRR、低压降、150mA 线性稳压器

1 特性

- 输入电压：+2.5V 至 +6.5V
- 提供多个输出版本：
  - 固定输出电压范围：0.9V 至 5V
  - 可调节输出电压范围为 0.9V 至 6.2V
- 超高 PSRR：
  - 1kHz 时 70dB，100kHz 时 67dB，1MHz 时 45dB
- 出色的负载和线路瞬态响应
- 超低压降：150mA 时为 170mV（典型值）
- 低噪声：30μV_{RMS} 典型值（100Hz 至 100kHz）
- 小型 5 引脚 SC-70、2mm × 2mm 晶圆级小外形无引线 (WSON)-6 封装和 1.5mm × 1.5mm WSON-6 封装

2 应用

- 摄像机传感器电源
- 移动电话耳机
- 掌上电脑 (PDA) 和智能手机
- 无线 LAN， Bluetooth®

3 说明

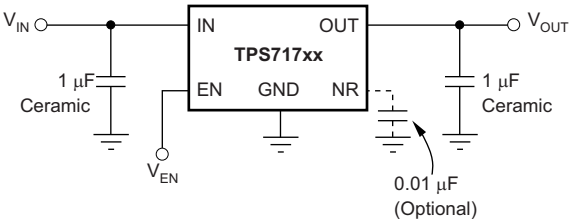
TPS717xx 系列低压降 (LDO)、低功耗线性稳压器采用超小型 5 引脚小外形尺寸晶体管 (SOT) 封装，其具有非常高的电源抑制比 (PSRR)，同时能够保持 45μA 的超低接地电流。 该系列稳压器采用先进的双极 CMOS (BiCMOS) 工艺和功率金属氧化物半导体场效应晶体管 (PMOSFET) 无源器件，可实现快速启动、超低噪声、优异的瞬态响应以及出色的 PSRR 性能。 TPS717xx 器件与 1μF 陶瓷输出电容一起工作时可保持稳定，并且使用了一个精确的电压基准和反馈环路，以在所有负载、线路、过程和温度变化范围内实现至少 3% 的精度。 该器件系列的额定温度范围为 T_J = -40°C 至 125°C，并且提供小型 SOT (SC70-5) 封装、带有散热焊盘的 2mm × 2mm WSON-6 封装以及 1.5mm x 1.5mm WSON-6 封装，非常适合小尺寸便携式设备（例如无线手持设备和 PDA）。

器件信息(1)

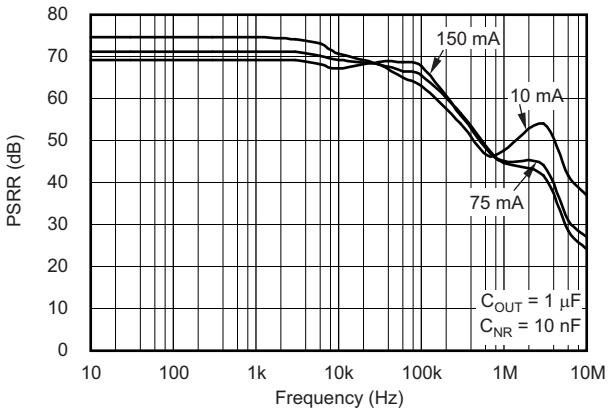
器件型号	封装	封装尺寸（标称值）
TPS717xx	SC70 (5)	2.00mm × 1.25mm
	WSON (6)	2.00mm x 2.00mm
	WSON (6)	1.50mm x 1.50mm

(1) 如需了解所有可用封装和电压选项，请见数据表末尾的可订购产品附录。

针对固定电压版本的典型应用电路



PSRR 与频率间的关系



Power-Supply Rejection Ratio (V_{IN} – V_{OUT} = 1 V)

目录

4 修订历史记录

Changes from Revision G (April 2009) to Revision H **Page**

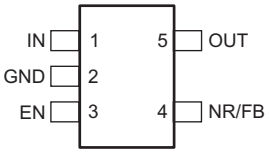
- Changed pin descriptions throughout *Pin Functions* table 3
- Added *ESD Ratings* table, *Feature Description* section, *Device Functional Modes*, *Application and Implementation* section, *Power Supply Recommendations* section, *Layout* section, *Device and Documentation Support* section, and *Mechanical, Packaging, and Orderable Information* section 4
- Changed load regulation typical specification from 120 µV to 70 µV to better reflect device performance 5
- Changed condition for C_{NR} = none for V_n parameter 5
- Changed Figure 1, Figure 2, Figure 3, and Figure 4: removed legend, added call-outs for clarity 6
- Changed titles of Figure 15, Figure 17, and Figure 25 7
- Corrected input and output symbols in operational amplifiers in *Functional Block Diagrams* 11
- Changed *Undervoltage Lockout (UVLO)* section text: reworded for clarity 13
- Deleted *Reverse Current Protection* section 15

Changes from Revision F (February 2009) to Revision G **Page**

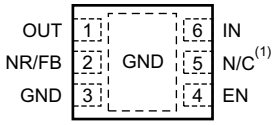
- Changed min and max specs for *Output accuracy,* $V_{OUT} \geq 1.0V$ 5

5 Pin Configuration and Functions

DCK Package
SC70-5
(Top View)

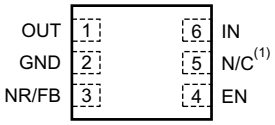


DRV Package
2-mm × 2-mm WSON
(Top View)



(1) N/C = No connection

DSE Package
1.5-mm × 1.5-mm WSON
(Top View)



Pin Functions

PIN				I/O	DESCRIPTION
NAME	DCK	DRV	DSE		
EN	3	4	4	I	Driving the enable pin (EN) above $V_{EN(high)}$ turns on the regulator. Driving this pin below $V_{EN(low)}$ puts the regulator into standby mode, thereby disabling the output and reducing operating current.
FB	4	2	3	I	Adjustable voltage version only. The voltage at this pin is fed to the error amplifier. A resistor divider from OUT to FB sets the output voltage when in regulation.
GND	2	3	2	—	Ground
IN	1	6	6	I	Input to the device. A 0.1-µF to 1-µF capacitor is recommended for better performance.
N/C	—	5	5	—	Not connected. This pin can be tied to ground to improve thermal dissipation.
NR	4	2	3	—	Fixed voltage versions only. The noise reduction capacitor filters the noise generated by the internal band gap, thus lowering output noise.
OUT	5	1	1	O	This pin is the regulated output voltage. A minimum capacitance of 1 µF is required for stability from this pin to ground.

6 Specifications

6.1 Absolute Maximum Ratings

over operating temperature range (unless otherwise noted), all voltages are with respect to GND(1)

		MIN	MAX	UNIT
Voltage	V_{IN}	–0.3	7	V
	V_{FB}	–0.3	3.6	V
	V_{NR}	–0.3	3.6	V
	V_{EN}	–0.3	V_{IN} + 0.3 V(2)	V
	V_{OUT}	–0.3	7	V
Current	I_{OUT}	Internally limited		A
Continuous total power dissipation	P_{DISS}	See *Thermal Information*		
Operating junction temperature	T_J	–55	150	°C
Storage temperature	T_{stg}	–55	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) V_{EN} absolute maximum rating is V_{IN} + 0.3 V or 7 V, whichever is greater.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins(1)	±2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins(2)	±500	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating junction temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V_{IN}	Input voltage	2.5		6.5	V
V_{OUT}	Output voltage	0.9		5	V
I_{OUT}	Output current	0		150	mA
V_{EN}	Enable voltage	0		V_{IN}	V
C_{OUT}	Output capacitor	1		100	µF
T_J	Junction temperature	–40		125	°C

6.4 Thermal Information

THERMAL METRIC(1)		TPS717xx			UNIT
		DCK	DRV	DSE	
		5 PINS	6 PINS	6 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	279.2	71.1	190.5	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	57.5	96.5	94.9	
$R_{\theta JB}$	Junction-to-board thermal resistance	74.1	40.5	149.3	
ψ_{JT}	Junction-to-top characterization parameter	0.8	2.7	6.4	
ψ_{JB}	Junction-to-board characterization parameter	73.1	40.9	152.8	
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	n/a	10.7	n/a	

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, SPRA953.

6.5 Electrical Characteristics

Over operating temperature range (T_J = –40°C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN}, C_{OUT} = 1.0 µF, C_{NR} = 0.01 µF, unless otherwise noted. For TPS71701, V_{OUT} = 2.8 V. Typical values are at T_J = 25°C.

PARAMETER			TEST CONDITIONS		MIN	TYP	MAX	UNIT
V_{IN}	Input voltage range(1)				2.5		6.5	V
V_{FB}	Internal reference (TPS71701)				0.790	0.800	0.810	V
V_{OUT}	Output voltage range	(TPS717xx)			0.9		5.0	V
		(TPS71701)			0.9		6.5 – V_{DO}	V
V_{OUT}	Output accuracy	Nominal	T_J = 25°C			±2.5		mV
	Output accuracy (V_{OUT} < 1.0 V)	Over V_{IN}, I_{OUT}, Temp(2)	V_{OUT} + 0.5 V ≤ V_{IN} ≤ 6.5 V 0 mA ≤ I_{OUT} ≤ 150 mA		–30		+30	mV
	Output accuracy (V_{OUT} ≥ 1.0 V)	Over V_{IN}, I_{OUT}, Temp(2)	V_{OUT} + 0.5 V ≤ V_{IN} ≤ 6.5 V 0 mA ≤ I_{OUT} ≤ 150 mA		–3.0%		+3.0%	
$\Delta V_{OUT(\Delta VIN)}$	Line regulation (1)		$V_{OUT(nom)}$ + 0.5 V ≤ V_{IN} ≤ 6.5 V, I_{OUT} = 5 mA			125		µV/V
$\Delta V_{OUT(\Delta IOUT)}$	Load regulation		0 mA ≤ I_{OUT} ≤ 150 mA			70		µV/mA
V_{DO}	Dropout voltage(3) (V_{IN} = $V_{OUT(nom)}$ – 0.1 V)		I_{OUT} = 150 mA			170	300	mV
I_{LIM} (fixed)	Output current limit (fixed output)		V_{OUT} = 0.9 × $V_{OUT(nom)}$		200	325	575	mA
I_{LIM} (adjustable)	Output current limit (TPS71701)		V_{OUT} = 0.9 × $V_{OUT(nom)}$		200	325	575	mA
I_{GND}	Ground pin current		I_{OUT} = 0.1 mA			45	80	µA
			I_{OUT} = 150 mA			100		µA
I_{SHDN}	Shutdown current (I_{GND})		V_{EN} ≤ 0.4 V, T_J = –40°C to 85°C	2.5 V ≤ V_{IN} < 4.5 V		0.20	1.5	µA
				4.5 V ≤ V_{IN} ≤ 6.5 V		0.90		µA
I_{FB}	Feedback pin current (TPS71701)					0.02	1.0	µA
PSRR	Power-supply rejection ratio		V_{IN} = 3.8 V, V_{OUT} = 2.8 V, I_{OUT} = 150 mA	f = 100 Hz		70		dB
				f = 1 kHz		70		dB
				f = 10 kHz		67		dB
				f = 100 kHz		67		dB
				f = 1 MHz		45		dB
V_n	Output noise voltage		BW = 100 Hz to 100 kHz, V_{IN} = 3.8 V, V_{OUT} = 2.8 V, I_{OUT} = 10 mA	C_{NR} = none		95 × V_{OUT}		μV_{RMS}
				C_{NR} = 0.001 µF		25 × V_{OUT}		μV_{RMS}
				C_{NR} = 0.01 µF		12.5 × V_{OUT}		μV_{RMS}
				C_{NR} = 0.1 µF		11.5 × V_{OUT}		μV_{RMS}
t_{STR}	Startup time		V_{OUT} = 90% $V_{OUT(nom)}$, R_L = 19 Ω, C_{OUT} = 1 µF	0.9 V ≤ V_{OUT} ≤ 1.6V, C_{NR} = 0.001 µF		0.700		ms
				1.6 V < V_{OUT} < V_{MAX}, C_{NR} = 0.01 µF		0.160		ms
$V_{EN(high)}$	Enable high (enabled)		V_{IN} ≤ 5.5 V		1.2		6.5(4)	V
			5.5 V < V_{IN} ≤ 6.5 V		1.25		6.5	V
$V_{EN(low)}$	Enable low (shutdown)				0		0.4	V
$I_{EN(high)}$	Enable pin current, enabled		EN = 6.5 V			0.02	1.0	µA
UVLO	Undervoltage lockout		V_{IN} rising		2.41	2.45	2.49	V
	Hysteresis		V_{IN} falling			150		mV
T_{sd}	Thermal shutdown temperature		Shutdown, temperature increasing			160		°C
			Reset, temperature decreasing			140		°C
T_J	Operating junction temperature				–40		125	°C

(1) Minimum V_{IN} = V_{OUT} + V_{DO} or 2.5 V, whichever is greater.
(2) Does not include external resistor tolerances.
(3) V_{DO} is not measured for devices with $V_{OUT(nom)}$ < 2.6 V because the minimum $V_{IN}$is 2.5 V.
(4) Maximum $V_{EN(high)}$ = V_{IN} + 0.3 or 6.5 V, whichever is smaller.

6.6 Typical Characteristics

Over operating temperature range (T_J = –40°C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN}, C_{OUT} = 1 µF, C_{NR} = 0.01 µF, unless otherwise noted. For the adjustable version (TPS71701,) V_{OUT} = 2.8 V. Typical values are at T_A = 25°C.

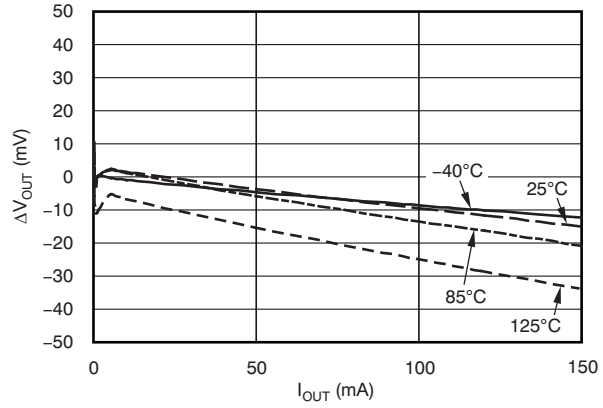


Figure 1. Load Regulation

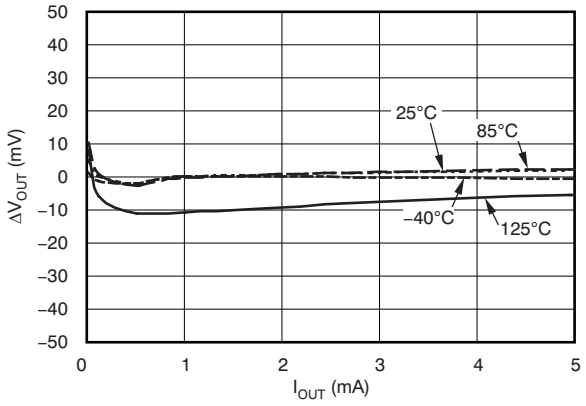


Figure 2. Load Regulation Under Light Loads

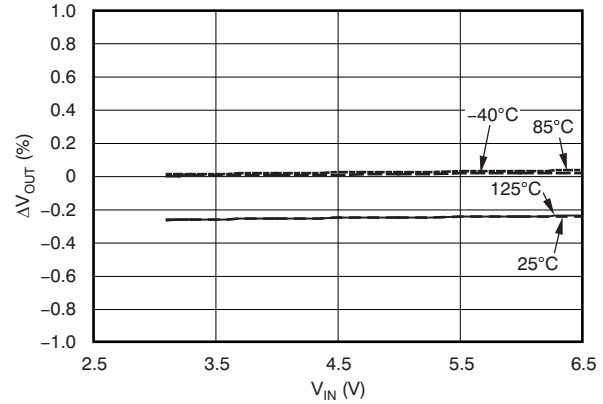


Figure 3. Line Regulation (I_{OUT} = 5 mA)

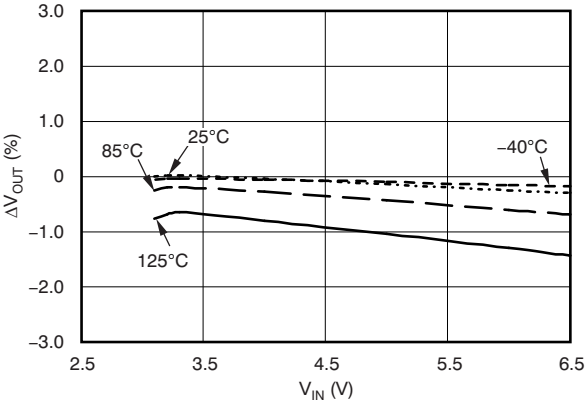


Figure 4. Line Regulation (I_{OUT} = 150 mA)

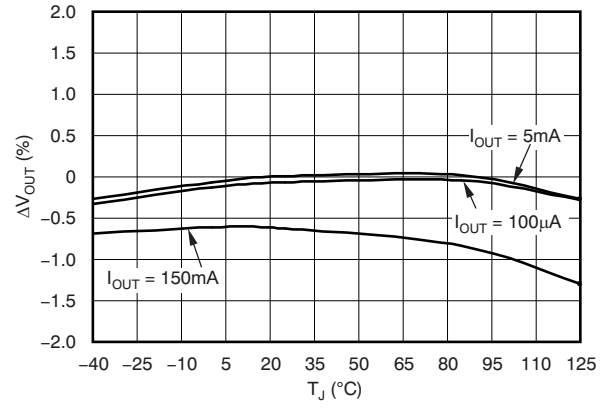


Figure 5. Output Voltage vs Temperature

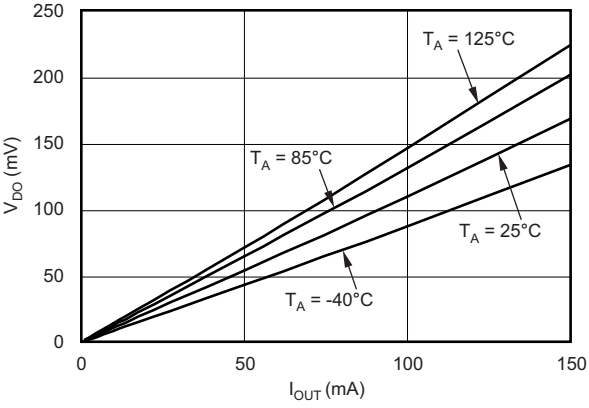


Figure 6. Dropout Voltage vs Output Current

Typical Characteristics (continued)

Over operating temperature range (T_J = –40°C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN}, C_{OUT} = 1 µF, C_{NR} = 0.01 µF, unless otherwise noted. For the adjustable version (TPS71701,) V_{OUT} = 2.8 V. Typical values are at T_A = 25°C.

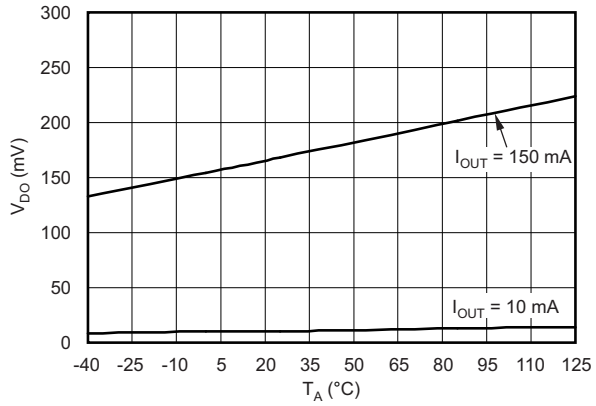


Figure 7. Dropout Voltage vs Temperature

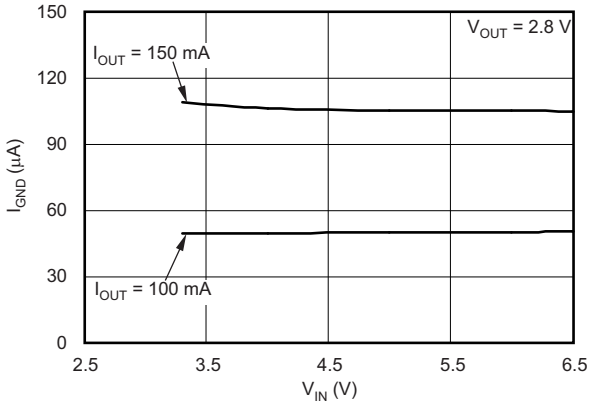


Figure 8. Ground Pin Current vs Input Voltage

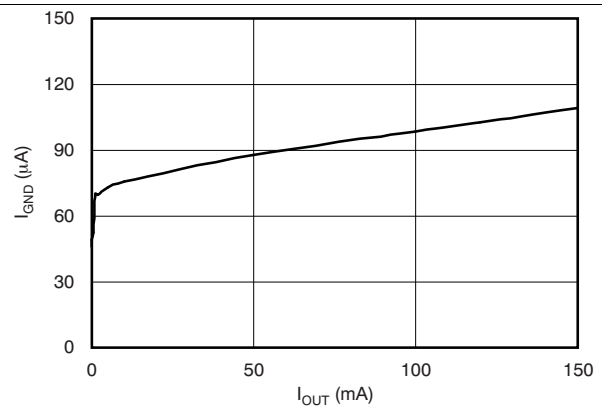


Figure 9. Ground Pin Current vs Output Current

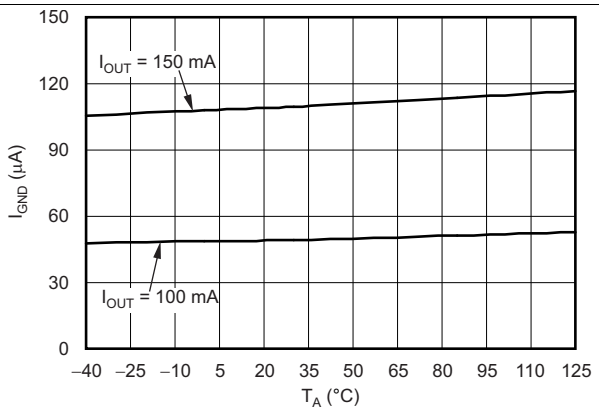


Figure 10. Ground Pin Current vs Temperature (Enabled)

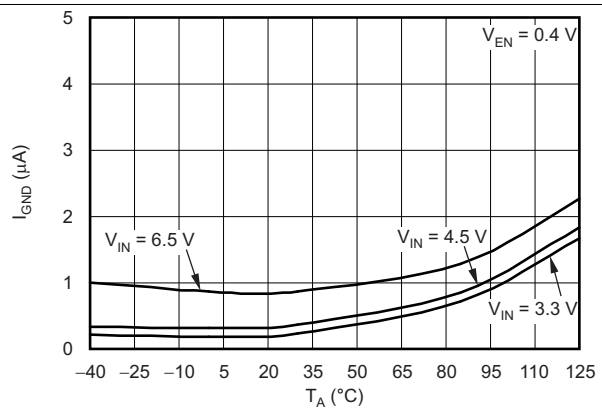


Figure 11. Ground Pin Current vs Temperature (Disabled)

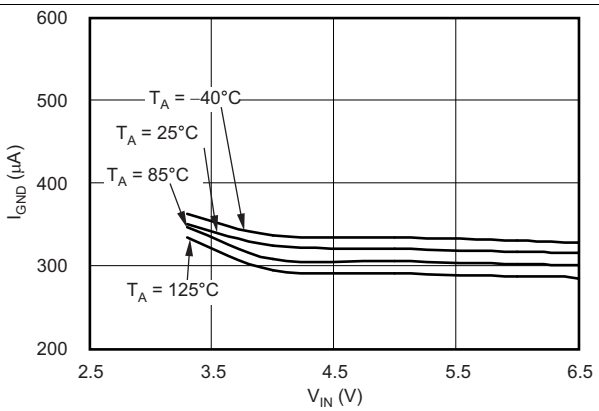


Figure 12. Current Limit vs Input Voltage

Typical Characteristics (continued)

Over operating temperature range (T_J = –40°C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN}, C_{OUT} = 1 µF, C_{NR} = 0.01 µF, unless otherwise noted. For the adjustable version (TPS71701,) V_{OUT} = 2.8 V. Typical values are at T_A = 25°C.

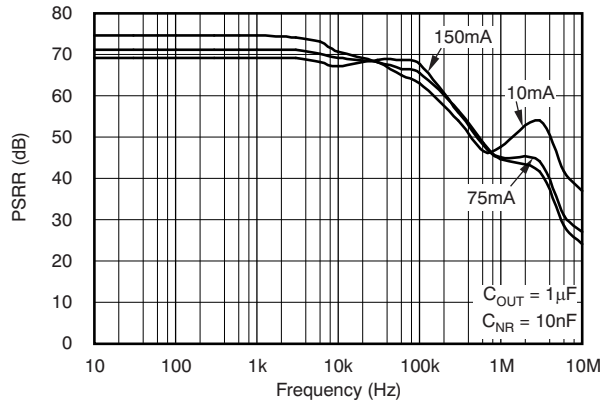


Figure 13. Power-Supply Ripple Rejection vs Frequency (V_{IN} – V_{OUT} = 1 V)

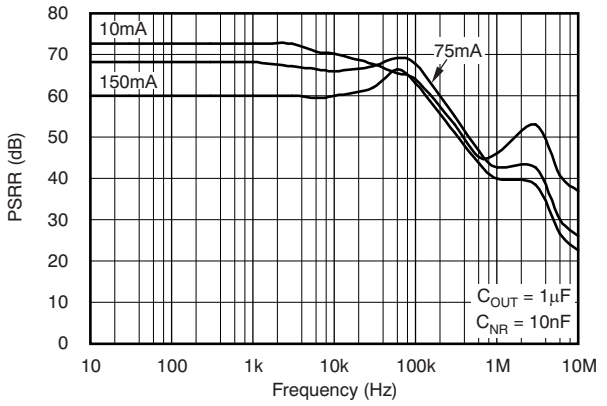


Figure 14. Power-Supply Ripple Rejection vs Frequency (V_{IN} – V_{OUT} = 0.5 V)

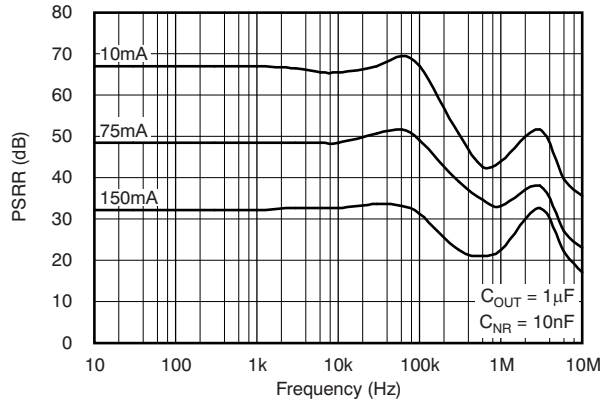


Figure 15. Power-Supply Ripple Rejection vs Frequency in Dropout Conditions (V_{IN} – V_{OUT} = 0.25 V)

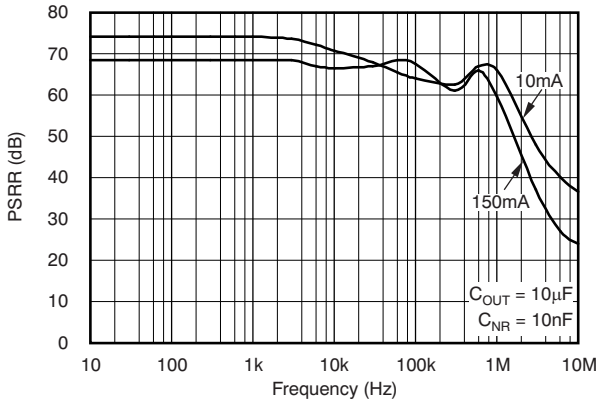


Figure 16. Power-Supply Ripple Rejection vs Frequency (V_{IN} – V_{OUT} = 1 V)

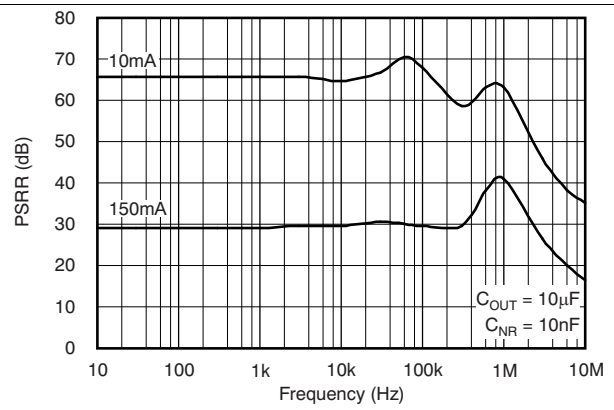


Figure 17. Power-Supply Ripple Rejection vs Frequency in Dropout Conditions (V_{IN} – V_{OUT} = 0.25 V)

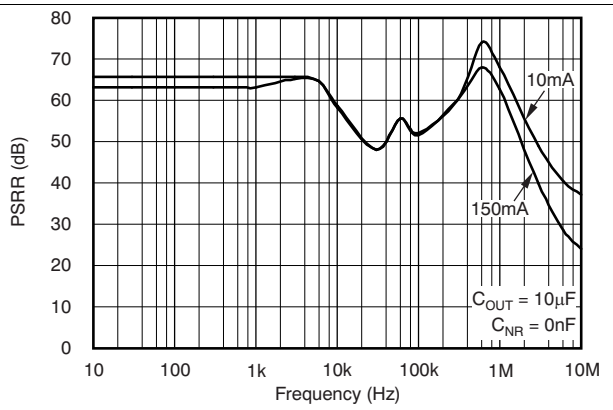


Figure 18. Power-Supply Ripple Rejection vs Frequency (V_{IN} – V_{OUT} = 1 V)

Typical Characteristics (continued)

Over operating temperature range (T_J = –40°C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN}, C_{OUT} = 1 µF, C_{NR} = 0.01 µF, unless otherwise noted. For the adjustable version (TPS71701,) V_{OUT} = 2.8 V. Typical values are at T_A = 25°C.

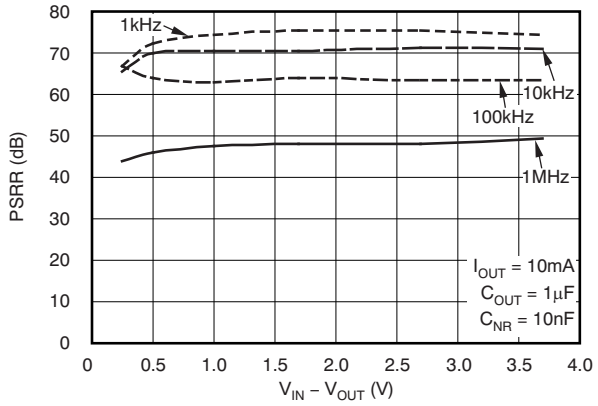


Figure 19. Power-Supply Ripple Rejection vs (V_{IN} – V_{OUT})

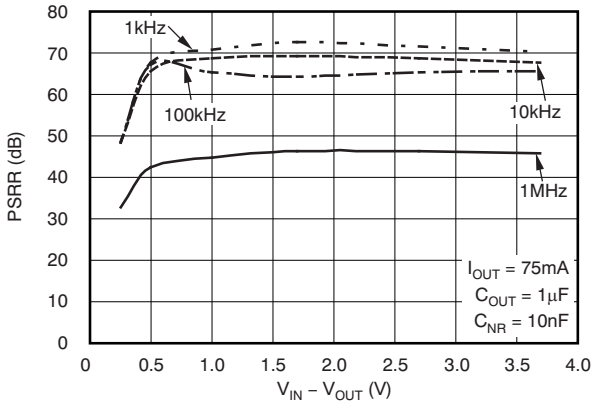


Figure 20. Power-Supply Ripple Rejection vs (V_{IN} – V_{OUT})

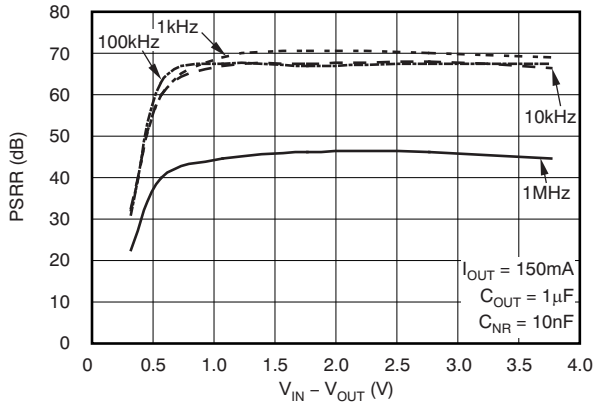


Figure 21. Power-Supply Ripple Rejection vs (V_{IN} – V_{OUT})

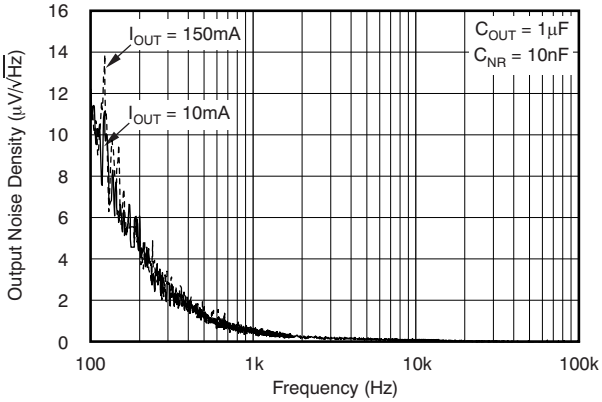


Figure 22. Output Spectral Noise Density vs Output Current

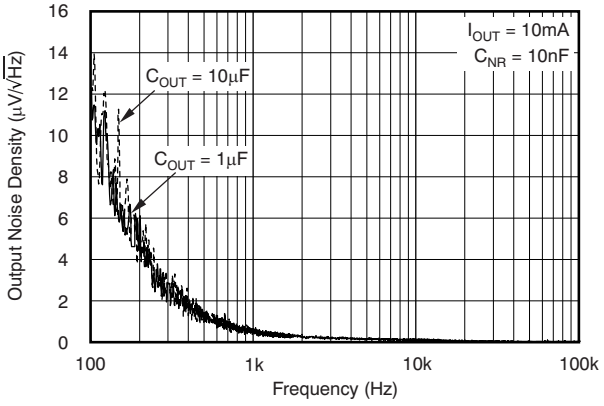


Figure 23. Output Spectral Noise Density vs Output Capacitance

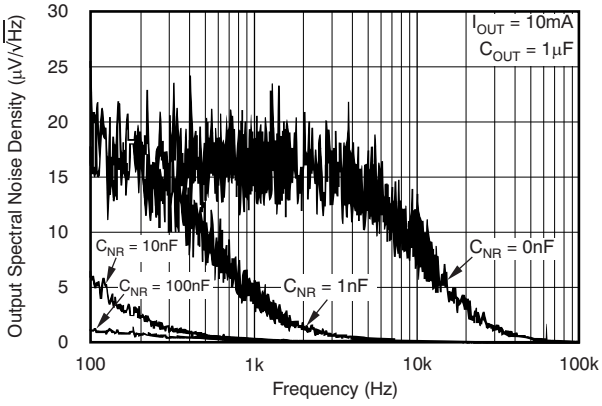


Figure 24. Output Spectral Noise Density vs Noise Reduction

Typical Characteristics (continued)

Over operating temperature range (T_J = –40°C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN}, C_{OUT} = 1 µF, C_{NR} = 0.01 µF, unless otherwise noted. For the adjustable version (TPS71701,) V_{OUT} = 2.8 V. Typical values are at T_A = 25°C.

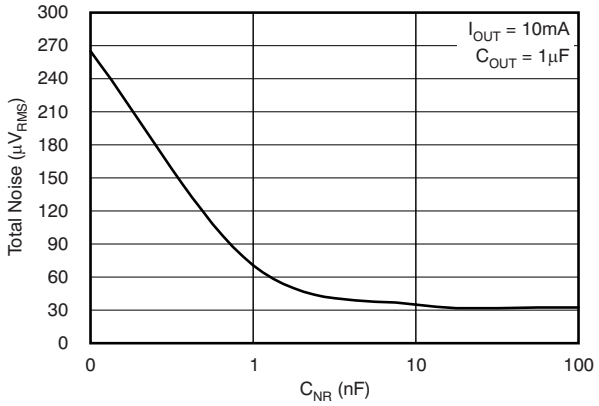


Figure 25. Total Output Noise vs Noise Reduction Capacitor

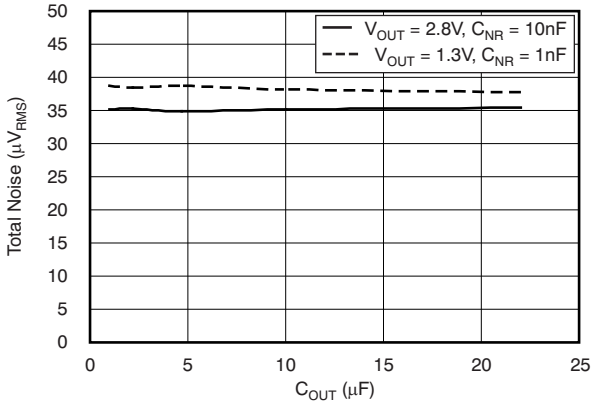


Figure 26. Total Output Noise vs Output Capacitance

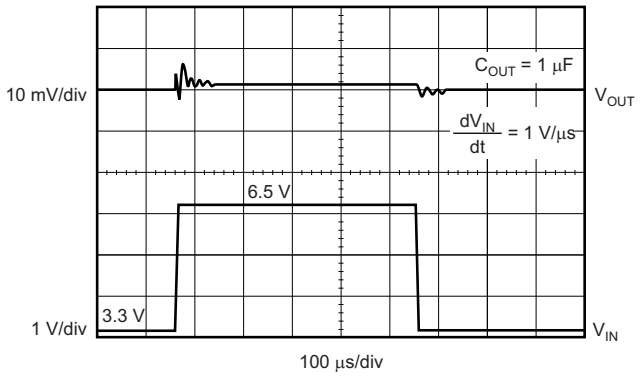


Figure 27. Line Transient Response

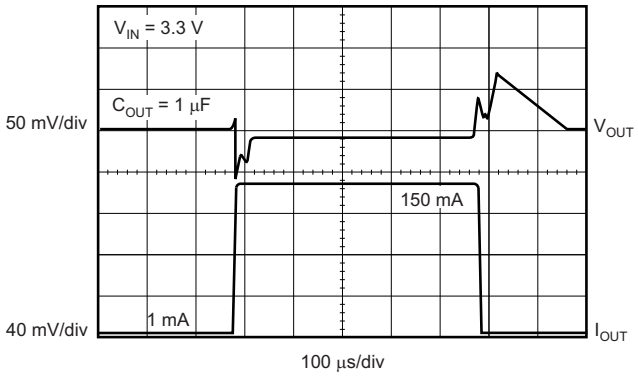


Figure 28. Load Transient Response

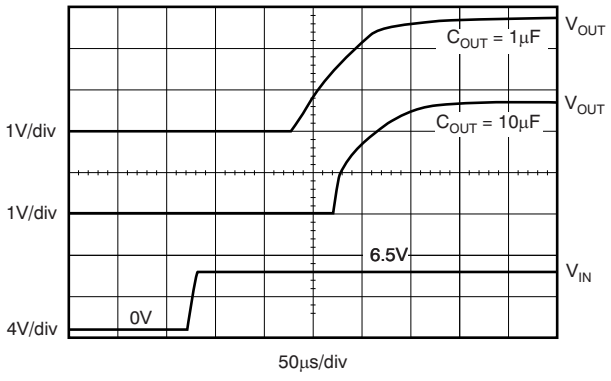


Figure 29. Turn-On Response

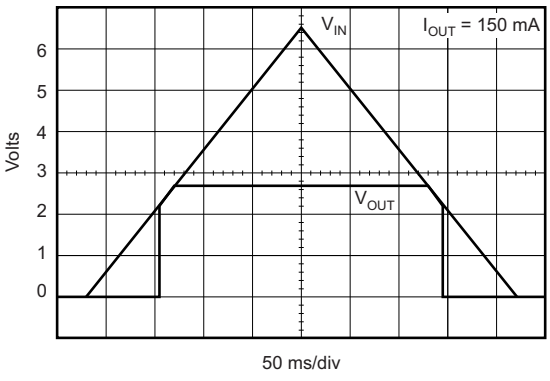


Figure 30. Power-Up and Power-Down

7 Detailed Description

7.1 Overview

The TPS717xx family of low-dropout (LDO) regulators combines the high performance required by many RF and precision analog applications with ultra-low current consumption. High PSRR is provided by a high-gain, high-bandwidth error loop with good supply rejection with very low headroom (V_{IN} – V_{OUT}). Fixed voltage versions provide a noise reduction pin to bypass noise generated by the band-gap reference and to improve PSRR. A quick-start circuit fast-charges this capacitor at startup. The combination of high performance and low ground current also make the TPS717xx family of devices an excellent choice for battery-powered applications. All versions have thermal and overcurrent protection.

7.2 Functional Block Diagrams

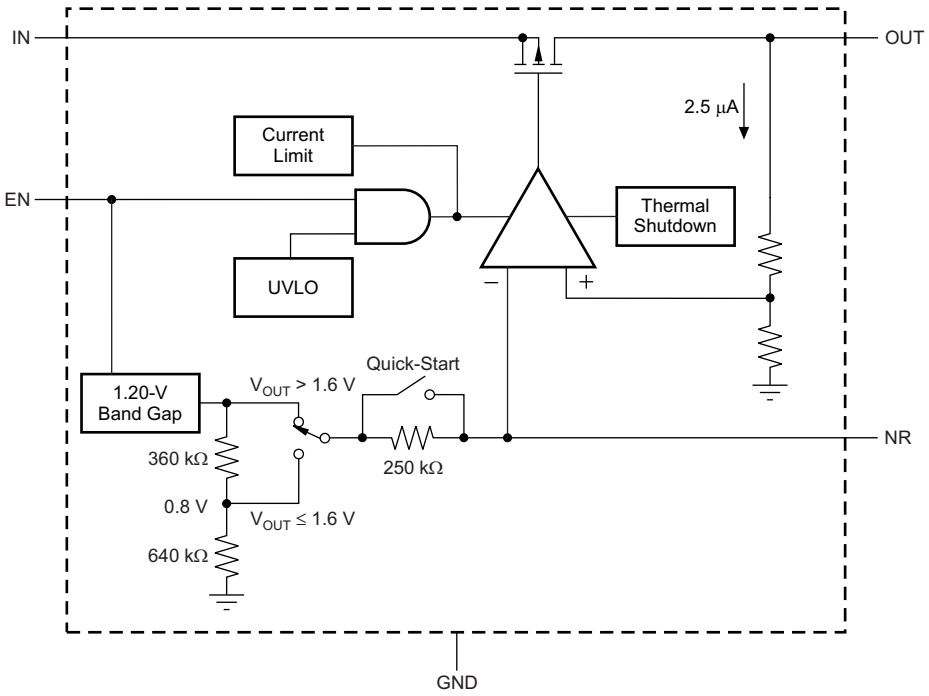


Figure 31. Fixed Voltage Versions

Functional Block Diagrams (continued)

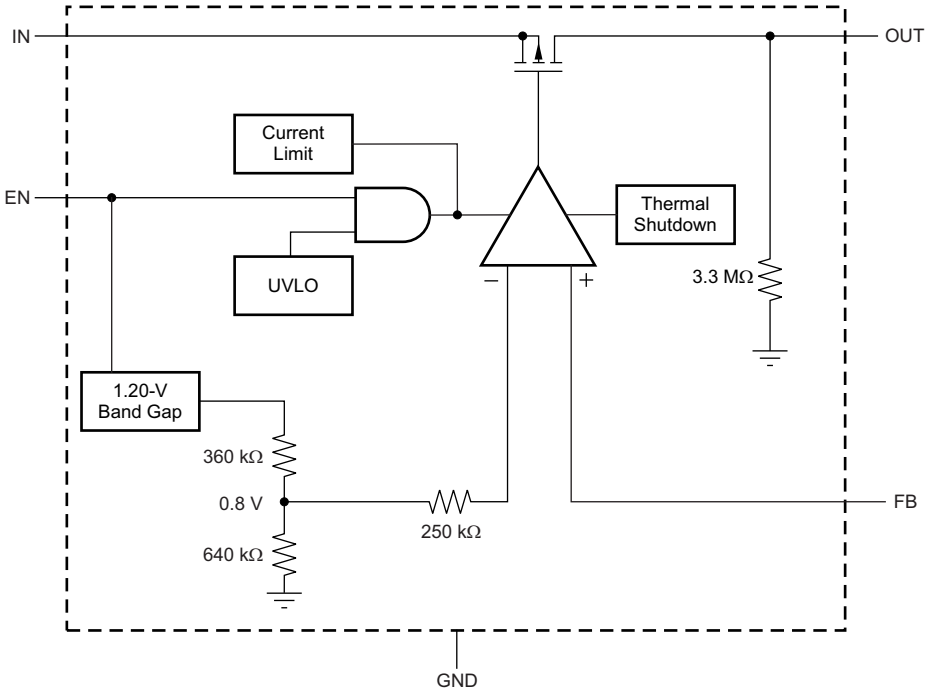


Figure 32. Adjustable Voltage Version

7.3 Feature Description

7.3.1 Internal Current Limit

The TPS717xx internal current limit helps protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current that is largely independent of output voltage. For reliable operation, do not operate the device in a current-limit state for extended periods of time.

The PMOS pass element in the TPS717xx has a built-in body diode that conducts current when the voltage at OUT exceeds the voltage at IN. This current is not limited, so if extended reverse voltage operation is anticipated, external limiting may be appropriate.

7.3.2 Shutdown

The enable pin (EN) is active high and compatible with standard and low voltage, TTL-CMOS levels. When shutdown capability is not required, EN can be connected to IN.

7.3.3 Startup and Noise Reduction Capacitor

Fixed voltage versions of the TPS717xx use a quick-start circuit to fast-charge the noise reduction capacitor, C_{NR}, if present (see Figure 31). This circuit allows the combination of very low output noise and fast start-up times. The NR pin is high impedance, so a low-leakage C_{NR} capacitor must be used; most ceramic capacitors are appropriate in this configuration.

Note that for fastest startup, apply V_{IN} first, then the enable pin (EN) driven high. If EN is tied to IN, startup is somewhat slower. Refer to Figure 29 in *Typical Characteristics*. The quick-start switch is closed for approximately 135 µs. To ensure that C_{NR} is fully charged during the quick-start time, use a 0.01-µF or smaller capacitor.

Feature Description (continued)

For output voltages below 1.6 V, a voltage divider on the band-gap reference voltage is employed to optimize output regulation performance for lower output voltages. This configuration results in an additional resistor in the quick-start path and combined with the noise reduction capacitor (C_{NR}) results in slower start-up times for output voltages below 1.6 V.

Equation 1 approximates the start-up time as a function of C_{NR} for output voltages below 1.6 V:

$$t_{START} = 160\mu s + \left(540 \frac{\mu s}{nF} \times C_{NR} nF\right)\mu s \quad (1)$$

7.3.4 Undervoltage Lockout (UVLO)

The TPS717xx uses an undervoltage lockout circuit to keep the output shut off until the internal circuitry is operating properly. The UVLO circuit has a limited glitch immunity so undershoot transients are typically ignored on the input if these transients are less than 5 µs in duration.

7.3.5 Minimum Load

The TPS717xx is stable with no output load. Traditional PMOS LDO regulators suffer from lower loop gain at very light output loads. The TPS717xx employs an innovative low-current mode circuit to increase loop gain under very light or no-load conditions, resulting in improved output voltage regulation performance down to zero output current.

7.3.6 Thermal Protection

Thermal protection disables the output when the junction temperature rises to approximately 160°C, allowing the device to cool. When the junction temperature cools to approximately 140°C the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit can cycle on and off. This cycling limits the dissipation of the regulator, protecting it from damage because of overheating.

Any tendency to activate the thermal protection circuit indicates excessive power dissipation or an inadequate heatsink. For reliable operation, limit junction temperature to 125°C maximum. To estimate the margin of safety in a complete design (including heatsink), increase the ambient temperature until the thermal protection is triggered; use worst-case loads and signal conditions. For good reliability, trigger thermal protection at least 35°C above the maximum expected ambient condition of a particular application. This configuration produces a worst-case junction temperature of 125°C at the highest expected ambient temperature and worst-case load.

The internal protection circuitry of the TPS717xx is designed to protect against overload conditions. This circuitry is not intended to replace proper heatsinking. Continuously running the TPS717xx into thermal shutdown degrades device reliability.

7.4 Device Functional Modes

7.4.1 Normal Operation

The device regulates to the nominal output voltage under the following conditions:

- The input voltage has previously exceeded the UVLO rising voltage and has not decreased below the UVLO falling threshold.
- The input voltage is greater than the nominal output voltage added to the dropout voltage.
- The enable voltage has previously exceeded the enable rising threshold voltage and has not decreased below the enable falling threshold.
- The output current is less than the current limit.
- The device junction temperature is less than the maximum specified junction temperature.

Device Functional Modes (continued)

7.4.2 Dropout Operation

If the input voltage is lower than the nominal output voltage plus the specified dropout voltage, but all other conditions are met for normal operation, the device operates in dropout mode. In this condition, the output voltage is the same as the input voltage minus the dropout voltage. The transient performance of the device is significantly degraded because the pass device is in a triode state and no longer controls the current through the LDO. Line or load transients in dropout can result in large output voltage deviations.

7.4.3 Disabled

The device is disabled under the following conditions:

- The input voltage is less than the UVLO falling voltage, or has not yet exceeded the UVLO rising threshold.
- The enable voltage is less than the enable falling threshold voltage or has not yet exceeded the enable rising threshold.
- The device junction temperature is greater than the thermal shutdown temperature.

Table 1 shows the conditions that lead to the different modes of operation.

Table 1. Device Functional Mode Comparison

OPERATING MODE	PARAMETER			
	V_{IN}	V_{EN}	I_{OUT}	T_J
Normal mode	$V_{IN} > V_{OUT(nom)} + V_{DO}$ and $V_{IN} >$ UVLO	$V_{EN} > V_{EN(high)}$	$I_{OUT} < I_{LIM}$	$T_J < 125°C$
Dropout mode	UVLO $< V_{IN} < V_{OUT(nom)} + V_{DO}$	$V_{EN} > V_{EN(high)}$	—	$T_J < 125°C$
Disabled mode (any true condition disables the device)	$V_{IN} <$ UVLO $- V_{hys}$	$V_{EN} < V_{EN(low)}$	—	$T_J > 165°C$

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The TPS717xx belongs to a family of new generation LDO regulators that use innovative circuitry to achieve ultra-wide bandwidth and high loop gain, resulting in extremely high PSRR at very low headroom (V_{IN} – V_{OUT}). Fixed voltage versions provide a noise reduction pin to bypass noise generated by the band-gap reference and to improve PSRR while a quick-start circuit fast-charges this capacitor. These features, combined with low noise, enable, low ground pin current, and ultra-small packaging, make this part ideal for automotive applications. This family of regulators offers sub-band-gap output voltages, current limit, and thermal protection, and is fully specified from –40°C to 125°C.

8.1.1 Transient Response

As with any regulator, increasing the size of the output capacitor reduces overshoot or undershoot magnitude but increases duration of the transient. The TPS717xx has an ultra-wide loop bandwidth that allows it to respond quickly to load transient events. As with any regulator, the loop bandwidth is finite and the initial transient voltage peak is controlled by the sizing of the output capacitor. Typically, larger output capacitors reduce the peak while also reducing the bandwidth of the LDO, slowing the response time.

8.1.2 Input and Output Capacitor Requirements

Although an input capacitor is not required for stability, good analog design practice is to connect a 0.1-µF or larger low equivalent series resistance (ESR) capacitor from IN to GND near the regulator. This capacitor counteracts reactive input sources and improves transient response, noise rejection, and ripple rejection. A higher-value capacitor may be necessary if large, fast rise-time load transients are anticipated or if the device is located several inches from the power source. If source impedance is not sufficiently low, a 0.1-µF input capacitor may be necessary to ensure stability.

The TPS717xx is designed to be stable with ceramic output capacitors of values 1 µF or larger. The X5R- and X7R-type capacitors are best because they have minimal variation in value and ESR over temperature. The maximum ESR of the output capacitor must be less than 1 Ω.

8.1.3 Dropout Voltage

The TPS717xx uses a PMOS pass transistor to achieve low dropout. When (V_{IN} – V_{OUT}) is less than the dropout voltage (V_{DO}), the PMOS pass device is in its linear region of operation and the input-to-output resistance is the R_{DSon} of the PMOS pass element. V_{DO} scales approximately with output current because the PMOS device functions as a resistor in dropout.

As with any linear regulator, PSRR and transient response are degraded when (V_{IN} – V_{OUT}) approaches dropout. This effect is illustrated in Figure 15 through Figure 17 in *Typical Characteristics*.

Application Information (continued)

8.1.4 Output Noise

In most LDOs, the band gap is the dominant noise source. If a noise reduction capacitor (C_{NR}) is used with the TPS717xx, the band gap does not contribute significantly to noise. Instead, noise is dominated by the output resistor divider and the error amplifier input. To minimize noise in a given application, use a 0.01-µF (minimum) noise reduction capacitor; for the adjustable version, smaller value resistors in the output resistor divider reduce noise. A parallel combination that gives 2.5 µA of divider current has the same noise performance as a fixed voltage version.

Equation 2 approximates the total noise referred to the feedback point (FB pin) when C_{NR} = 0.01 µF:

$$V_N = 11.5 \frac{\mu V_{RMS}}{V} \times V_{OUT} \quad (2)$$

8.2 Typical Applications

8.2.1 Application for Fixed Voltage Versions and Adjustable Voltage Version

Figure 33 shows the basic circuit connections for the fixed voltage options. Figure 34 gives the connections for the adjustable output version (TPS71701). **Note that the NR pin is not available on the adjustable version**.

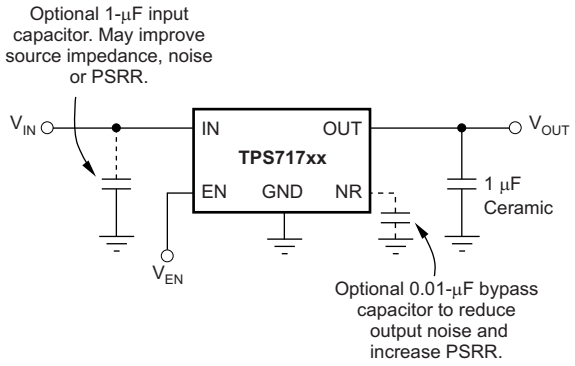


Figure 33. Typical Application Circuit (Fixed Voltage Versions)

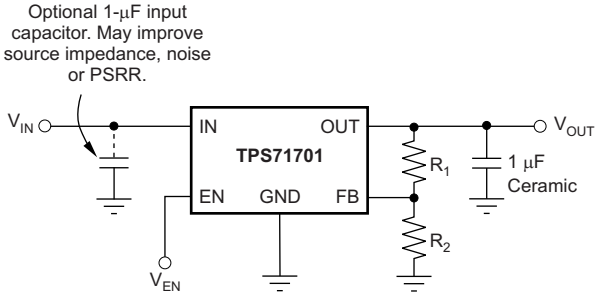


Figure 34. Typical Application Circuit (Adjustable Voltage Version)

8.2.1.1 Design Requirements

Table 2 summarizes the design requirements for Figure 36.

Table 2. Design Parameters

PARAMETER	DESIGN REQUIREMENT
Input voltage	3.3 V, ±10%
Output voltage	2.8 V, ±5%
Output current	100 mA typical, 150 mA peak
Output voltage transient deviation	5%
Maximum ambient temperature	85°C

8.2.1.2 Detailed Design Procedure

For the adjustable version (TPS71701), the NR pin is replaced with a feedback (FB) pin. The voltage on this pin sets the output voltage and is determined by the values of R_1 and R_2. The values of R_1 and R_2 can be calculated for any voltage using the formula given in Equation 3:

$$R1 = R2 * (VOUT / VREF - 1) \quad (3)$$

The value of R_2 directly impacts the operation of the device and must be chosen in the range of approximately 160 kΩ to 320 kΩ. Sample resistor values for common output voltages are shown in Table 3.

Table 3. Sample 1% Resistor Values for Common Output Voltages

V_{OUT}	R_1	R_2
1	80.6 kΩ	324 kΩ
1.2	162 kΩ	324 kΩ
1.5	294 kΩ	332 kΩ
1.8	402 kΩ	324 kΩ
2.5	665 kΩ	316 kΩ
3.3	1.02 MΩ	324 kΩ
5	1.74 MΩ	332 kΩ

8.2.1.3 Application Curve

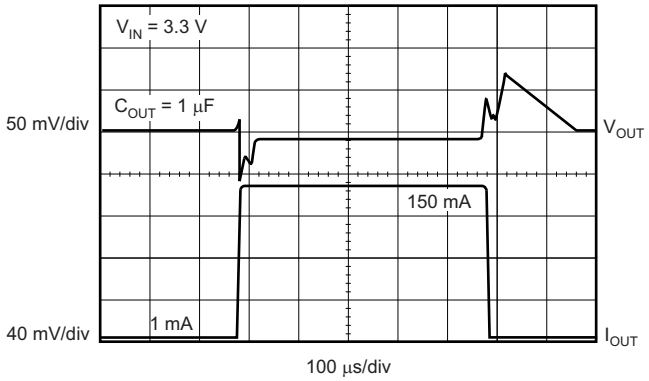


Figure 35. Load Transient Response

8.2.2 Powering a PLL Integrated on an SOC

Figure 36 shows the TPS71701 powering a phase-locked loop (PLL) that is integrated into a system-on-a-chip (SOC).

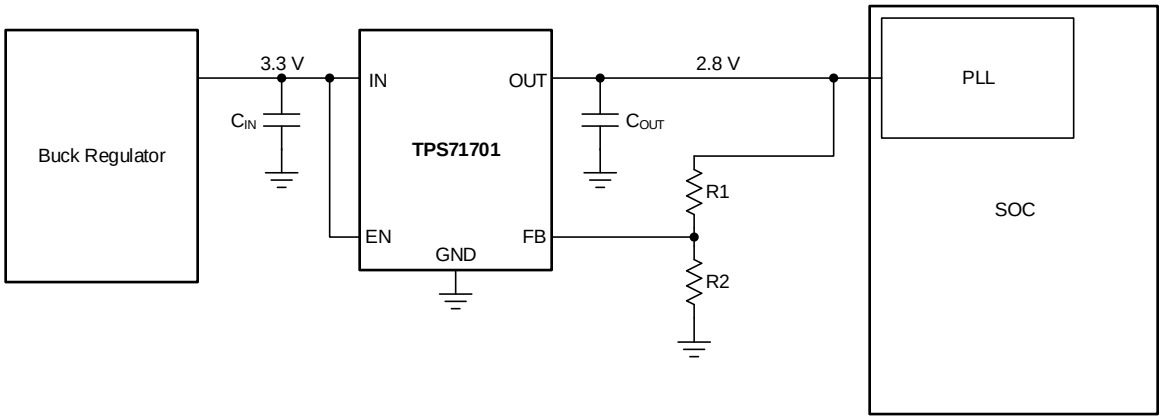


Figure 36. Typical Application Circuit: PLL on an SOC

Use the input and output capacitors to ensure the voltage transient requirements. A 1-µF input and 1-µF output capacitor are selected to maximize the capacitance and minimize capacitor size.

R_2 is chosen to be 158 kΩ for optimal noise and PSRR, and by Equation 4, R_1 is selected to be 402 kΩ. Both R_1 and R_2 must be 1% tolerance resistors to meet the dc accuracy specification over line, load, and temperature.

8.3 Do's and Don'ts

Do place at least one 1-µF ceramic capacitor as close as possible in the range of the regulator.

Do not place the output capacitor more than 10 mm away from the regulator.

Do not place any components in the feedback loop except for the output capacitor and feedback resistors.

Do not exceed the device absolute maximum ratings.

Do not float the enable (EN) pin.

9 Power Supply Recommendations

The TPS717xx is designed to operate from an input voltage between 2.5 V and 6.5 V. The input supply must provide adequate headroom for the device to operate in a normal mode of operation.

Connect a low output impedance power supply directly to the IN pin of the TPS717xx. Inductive impedances between the input supply and the IN pin can create significant voltage excursions at the IN pin during startup or load transient events. If inductive impedances are unavoidable, use an input capacitor. To increase the overall PSRR of the power solution, use a pi-filter before the input of the LDO or after the FB network of the LDO.

10 Layout

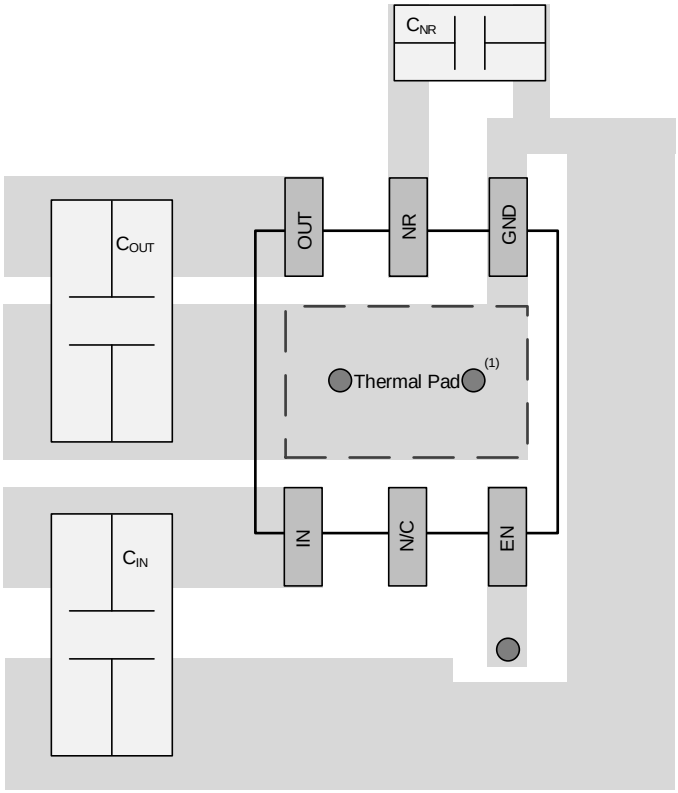
10.1 Layout Guidelines

For best overall performance, place all circuit components on the same side of the circuit board and as near as practical to the respective LDO pin connections. Place ground return connections to the input and output capacitor, and to the LDO ground pin as close to the GND pin as possible, connected by wide, component-side, copper surface area. The use of vias and long traces to create LDO component connections is strongly discouraged and negatively affects system performance. This grounding and layout scheme minimizes inductive parasitics, and thereby reduces load-current transients, minimizes noise, and increases circuit stability. A ground reference plane is also recommended and is either embedded in the printed circuit board (PCB) itself or located on the bottom side of the PCB opposite the components. This reference plane serves to assure accuracy of the output voltage, shields the LDO from noise, and functions similar to a thermal plane to spread (or sink) heat from the LDO device when connected to the thermal pad. In most applications, this ground plane is necessary to meet thermal requirements.

10.1.1 Board Layout Recommendations to Improve PSRR and Noise Performance

To improve ac performance (such as PSRR, output noise, and transient response), TI recommends that the board be designed with separate ground planes for V_{IN} and V_{OUT}, with each ground plane connected only at the GND pin of the device. In addition, the ground connection for the bypass capacitor must connect directly to the GND pin of the device.

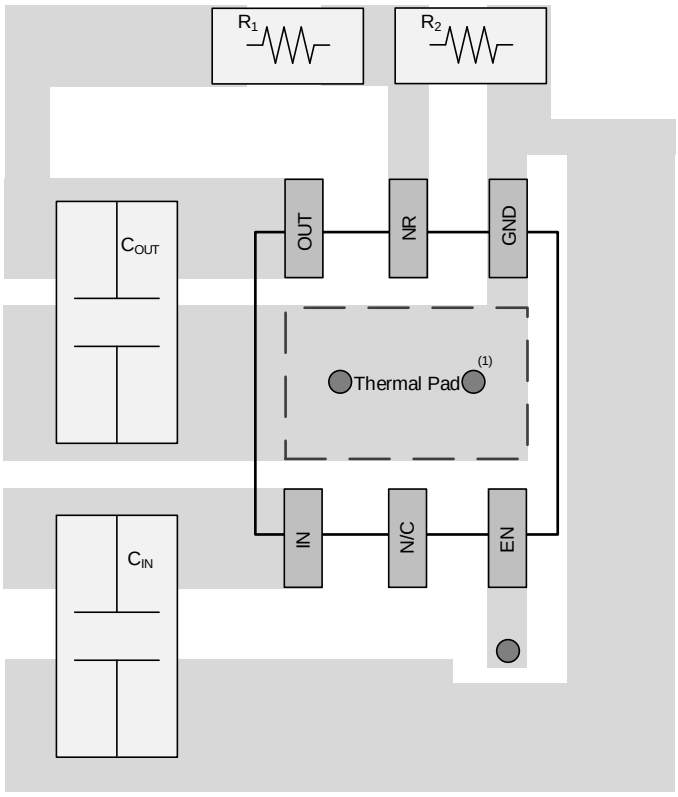
10.2 Layout Example



(1) Circles within thermal pad area indicate vias to other layers on the board, for electrical connections or thermal conduction.

Figure 37. Fixed Voltage Layout

Layout Example (continued)



(1) Circles within thermal pad area indicate vias to other layers on the board, for electrical connections or thermal conduction.

Figure 38. Adjustable Voltage Layout

10.3 Power Dissipation

The ability to remove heat from the die is different for each package type, presenting different considerations in the printed circuit board (PCB) layout. The PCB area around the device that is free of other components moves the heat from the device to the ambient air. Performance data for JEDEC low- and high-K boards are given in *Thermal Information*. Using heavier copper increases the effectiveness in removing heat from the device. The addition of plated through-holes to heat-dissipating layers also improves the heatsink effectiveness.

Power dissipation depends on input voltage and load conditions. Power dissipation (P_D) is equal to the product of the output current times the voltage drop across the output pass element (V_{IN} to V_{OUT}), as shown in Equation 4:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (4)$$

A better method of estimating the thermal measure comes from using the thermal metrics Ψ_{JT} and Ψ_{JB}, shown in *Thermal Information*. These metrics are a more accurate representation of the heat transfer characteristics of the die and the package than $R_{\theta JA}$. The junction temperature can be estimated with Equation 5.

$$\Psi_{JT}: \quad T_J = T_T + \Psi_{JT} \bullet P_D$$
$$\Psi_{JB}: \quad T_J = T_B + \Psi_{JB} \bullet P_D \quad (5)$$

where

- P_D is the power dissipation shown by Equation 4,
- T_T is the temperature at the center-top of the IC package,
- T_B is the PCB temperature measured 1 mm away from the IC package *on the PCB surface*.

Power Dissipation (接下页)

NOTE

Both T_T and T_B can be measured on actual application boards using a thermo-gun (an infrared thermometer).

For more information about measuring T_T and T_B, see the application note *Using New Thermal Metrics* (SBVA025), available for download at www.ti.com.

11 器件和文档支持

11.1 器件支持

11.1.1 开发支持

11.1.1.1 评估模块

评估模块 (EVM) 可与 TPS717 配套使用，帮助评估初始电路性能。 TPS717xxEVM-134 评估模块（和相关的用户指南）可在德州仪器 (TI) 网站上的产品文件夹中获取，也可直接从 TI 网上商店购买。

11.1.2 器件命名规则

表 **4.** 器件命名规则(1)

产品	V_{OUT}
TPS717**xx(x)yyyz**	**xx(x)** 为标称输出电压。 对于分辨率为 100mV 的输出电压，订货编号中使用两位数字；否则，使用三位数字（例如，28 = 2.8V；125 = 1.25V）。 **01** 表示可调电压版本。 **yyy** 为封装标识符。 **z** 为封装数量。 R 表示卷（3000 片），T 表示带（250 片）。

(1) 要获得最新的封装和订货信息，请参见本文档末尾的封装选项附录，或者访问器件产品文件夹（www.ti.com）。

11.2 文档支持

11.2.1 相关文档

《TPS717xxEVM-134 评估模块用户指南》，SLVU148

11.3 商标

Bluetooth is a registered trademark of Bluetooth SIG, Inc.
All other trademarks are the property of their respective owners.

11.4 静电放电警告

ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。 精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

11.5 术语表

SLYZ022 — *TI 术语表*。

这份术语表列出并解释术语、首字母缩略词和定义。

12 机械封装和可订购信息

以下页中包括机械封装和可订购信息。 这些信息是针对指定器件可提供的最新数据。 这些数据会在无通知且不对本文档进行修订的情况下发生改变。 欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS71701DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMT	Samples
TPS71701DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMT	Samples
TPS71701DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMT	Samples
TPS71701DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMT	Samples
TPS71709DSER	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FY	Samples
TPS71709DSERG4	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FY	Samples
TPS71709DSET	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FY	Samples
TPS71709DSETG4	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FY	Samples
TPS71710DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMU	Samples
TPS71710DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMU	Samples
TPS71710DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMU	Samples
TPS71710DRVR	ACTIVE	WSON	DRV	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	BMU	Samples
TPS71710DRVT	ACTIVE	WSON	DRV	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	BMU	Samples
TPS71711DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BRL	Samples
TPS71711DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BRL	Samples
TPS71711DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BRL	Samples
TPS71711DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BRL	Samples
TPS71712DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CKE	Samples
TPS71712DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CKE	Samples
TPS71712DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CKE	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS71712DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CKE	Samples
TPS71713DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMW	Samples
TPS71713DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMW	Samples
TPS71715DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CAA	Samples
TPS71715DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CAA	Samples
TPS71715DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CAA	Samples
TPS717185DSER	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	KB	Samples
TPS717185DSET	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	KB	Samples
TPS71718DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMX	Samples
TPS71718DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMX	Samples
TPS71718DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMX	Samples
TPS71718DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMX	Samples
TPS71718DSER	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	G6	Samples
TPS71718DSERG4	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	G6	Samples
TPS71718DSET	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	G6	Samples
TPS71719DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CCZ	Samples
TPS71719DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CCZ	Samples
TPS71719DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CCZ	Samples
TPS71719DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CCZ	Samples
TPS71721DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	NXL	Samples
TPS71721DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	NXL	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS71725DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CAF	Samples
TPS71725DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CAF	Samples
TPS71725DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CAF	Samples
TPS71726DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BRK	Samples
TPS71726DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BRK	Samples
TPS71727DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BSC	Samples
TPS71727DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BSC	Samples
TPS71727DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BSC	Samples
TPS71727DSER	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	KU	Samples
TPS71727DSET	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	KU	Samples
TPS717285DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BRJ	Samples
TPS717285DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BRJ	Samples
TPS71728DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMZ	Samples
TPS71728DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMZ	Samples
TPS71728DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BMZ	Samples
TPS71728DSER	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FU	Samples
TPS71728DSET	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FU	Samples
TPS71728DSETG4	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FU	Samples
TPS71729DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CJR	Samples
TPS71729DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CJR	Samples
TPS71730DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNA	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS71730DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNA	Samples
TPS71730DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNA	Samples
TPS71730DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNA	Samples
TPS71733DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNB	Samples
TPS71733DCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNB	Samples
TPS71733DCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNB	Samples
TPS71733DCKTG4	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNB	Samples
TPS71733DRVR	ACTIVE	WSON	DRV	6	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNB	Samples
TPS71733DRVRG4	ACTIVE	WSON	DRV	6	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	BNB	Samples
TPS71733DRVT	ACTIVE	WSON	DRV	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	BNB	Samples
TPS71733DSER	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FV	Samples
TPS71733DSET	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	FV	Samples
TPS71745DSER	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	GL	Samples
TPS71745DSET	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	GL	Samples
TPS71750DSER	ACTIVE	WSON	DSE	6	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	PD	Samples
TPS71750DSET	ACTIVE	WSON	DSE	6	250	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	PD	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

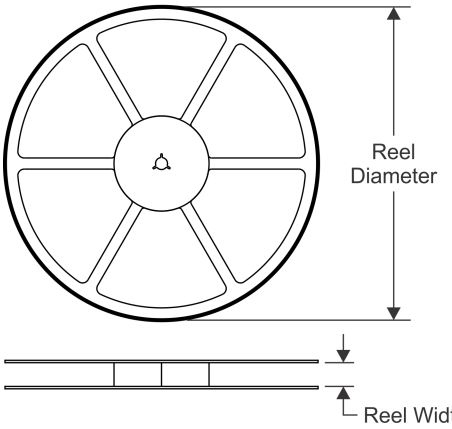
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

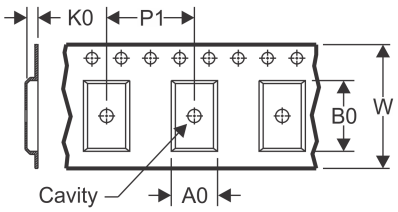
(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

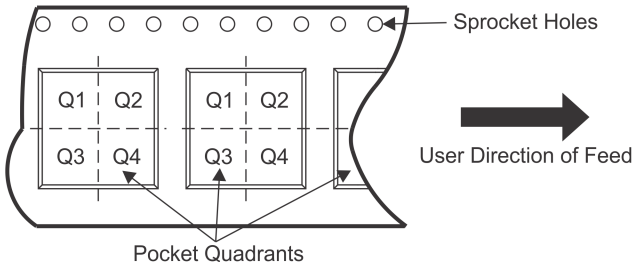


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



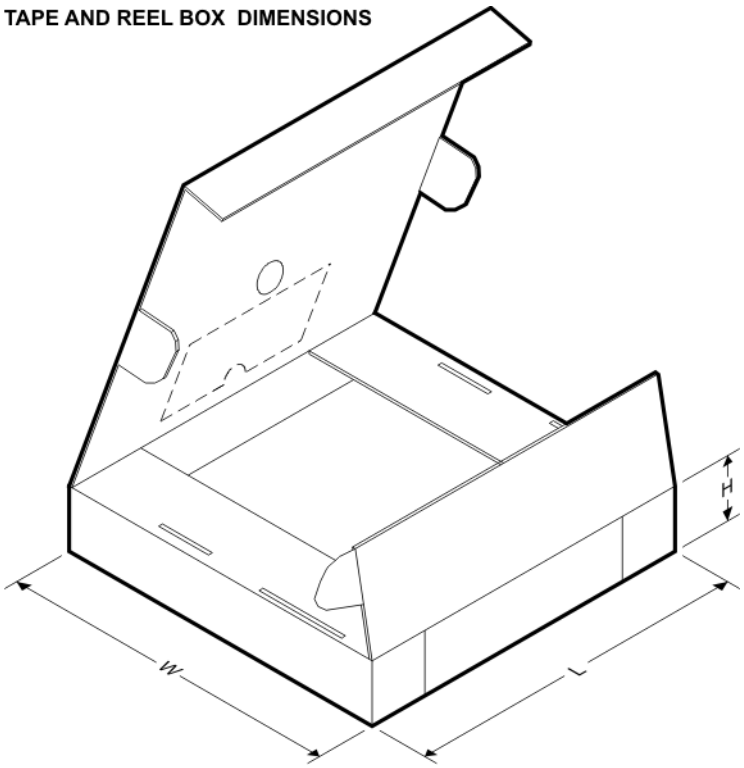
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS71701DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71701DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71701DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71709DSER	WSON	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71709DSET	WSON	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71710DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71710DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71710DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71710DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71710DRVR	WSON	DRV	6	3000	179.0	8.4	2.2	2.2	1.2	4.0	8.0	Q2
TPS71710DRVT	WSON	DRV	6	250	179.0	8.4	2.2	2.2	1.2	4.0	8.0	Q2
TPS71711DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71711DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71711DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71711DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71712DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71712DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71712DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS71712DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71713DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71713DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71713DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71713DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71715DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71715DCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71715DCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71715DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS717185DSER	WSON	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS717185DSET	WSON	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71718DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71718DCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71718DCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71718DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71718DSER	WSON	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71718DSET	WSON	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71719DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71719DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71719DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71719DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71721DCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71721DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71721DCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71721DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71725DCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71725DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71725DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71725DCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71726DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71726DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71726DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71726DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71727DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71727DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71727DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71727DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71727DSER	WSON	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71727DSET	WSON	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS717285DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS717285DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS717285DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS717285DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS71728DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71728DCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71728DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71728DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71728DSER	WSON	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71728DSET	WSON	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71729DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71729DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71729DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71729DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71730DCKR	SC70	DCK	5	3000	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71730DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71730DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71730DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71733DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71733DCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
TPS71733DCKT	SC70	DCK	5	250	179.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71733DCKT	SC70	DCK	5	250	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71733DRVR	WSON	DRV	6	3000	179.0	8.4	2.2	2.2	1.2	4.0	8.0	Q2
TPS71733DRVT	WSON	DRV	6	250	179.0	8.4	2.2	2.2	1.2	4.0	8.0	Q2
TPS71733DSER	WSON	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71733DSET	WSON	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71745DSER	WSON	DSE	6	3000	180.0	8.4	1.75	1.75	1.0	4.0	8.0	Q2
TPS71745DSET	WSON	DSE	6	250	180.0	8.4	1.75	1.75	1.0	4.0	8.0	Q2
TPS71750DSER	WSON	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS71750DSET	WSON	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2

TAPE AND REEL BOX DIMENSIONS



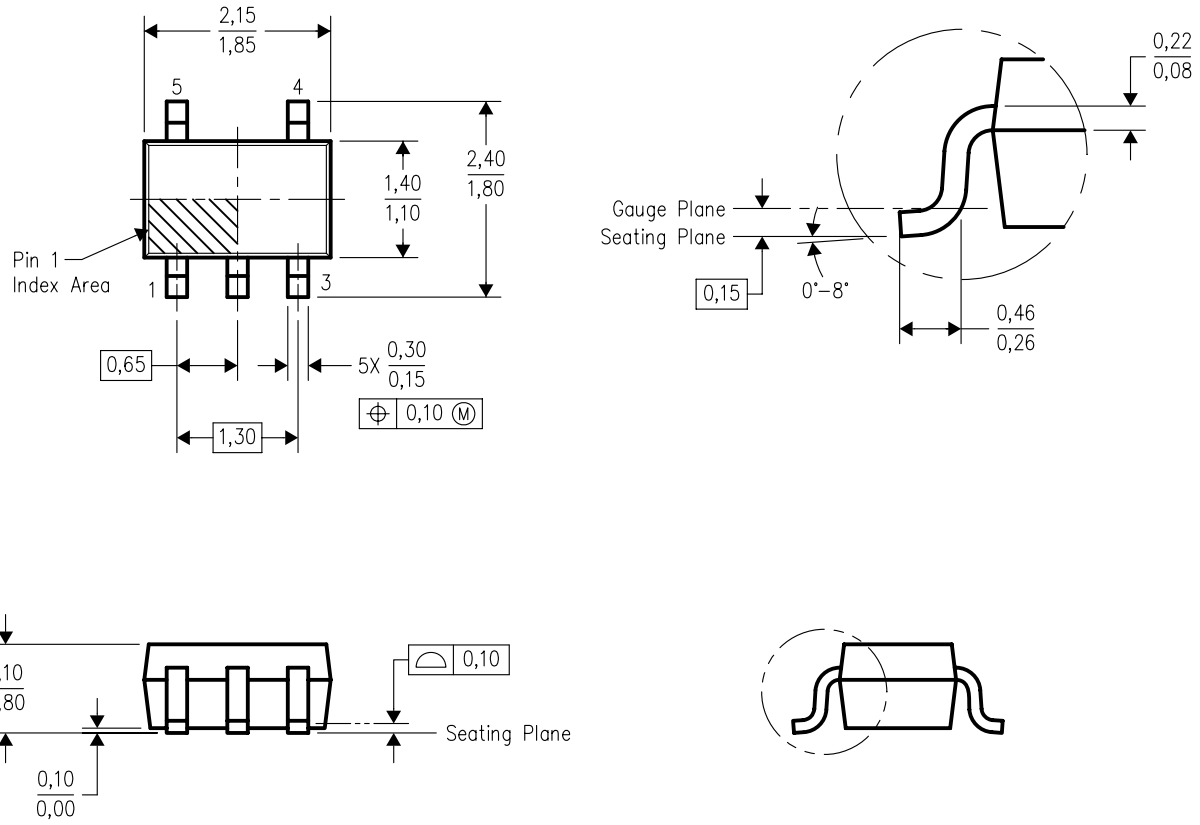
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS71701DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71701DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71701DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71709DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS71709DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS71710DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71710DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71710DCKT	SC70	DCK	5	250	340.0	340.0	38.0
TPS71710DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS71710DRVR	WSON	DRV	6	3000	200.0	183.0	25.0
TPS71710DRVT	WSON	DRV	6	250	203.0	203.0	35.0
TPS71711DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71711DCKR	SC70	DCK	5	3000	203.0	203.0	35.0
TPS71711DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS71711DCKT	SC70	DCK	5	250	340.0	340.0	38.0
TPS71712DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71712DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71712DCKT	SC70	DCK	5	250	200.0	183.0	25.0
TPS71712DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71713DCKR	SC70	DCK	5	3000	180.0	180.0	18.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS71713DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71713DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71713DCKT	SC70	DCK	5	250	200.0	183.0	25.0
TPS71715DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71715DCKR	SC70	DCK	5	3000	203.0	203.0	35.0
TPS71715DCKT	SC70	DCK	5	250	200.0	183.0	25.0
TPS71715DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS717185DSER	WSON	DSE	6	3000	203.0	203.0	35.0
TPS717185DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS71718DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71718DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71718DCKT	SC70	DCK	5	250	200.0	183.0	25.0
TPS71718DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71718DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS71718DSET	WSON	DSE	6	250	203.0	203.0	35.0
TPS71719DCKR	SC70	DCK	5	3000	203.0	203.0	35.0
TPS71719DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71719DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71719DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS71721DCKR	SC70	DCK	5	3000	203.0	203.0	35.0
TPS71721DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71721DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS71721DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71725DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71725DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71725DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71725DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS71726DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71726DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71726DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS71726DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71727DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71727DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71727DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS71727DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71727DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS71727DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS717285DCKR	SC70	DCK	5	3000	203.0	203.0	35.0
TPS717285DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS717285DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS717285DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71728DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71728DCKR	SC70	DCK	5	3000	203.0	203.0	35.0
TPS71728DCKT	SC70	DCK	5	250	203.0	203.0	35.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS71728DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71728DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS71728DSET	WSON	DSE	6	250	203.0	203.0	35.0
TPS71729DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71729DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71729DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71729DCKT	SC70	DCK	5	250	200.0	183.0	25.0
TPS71730DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71730DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71730DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71730DCKT	SC70	DCK	5	250	200.0	183.0	25.0
TPS71733DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71733DCKR	SC70	DCK	5	3000	200.0	183.0	25.0
TPS71733DCKT	SC70	DCK	5	250	203.0	203.0	35.0
TPS71733DCKT	SC70	DCK	5	250	180.0	180.0	18.0
TPS71733DRVR	WSON	DRV	6	3000	200.0	183.0	25.0
TPS71733DRVT	WSON	DRV	6	250	200.0	183.0	25.0
TPS71733DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS71733DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS71745DSER	WSON	DSE	6	3000	182.0	182.0	20.0
TPS71745DSET	WSON	DSE	6	250	182.0	182.0	20.0
TPS71750DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS71750DSET	WSON	DSE	6	250	200.0	183.0	25.0

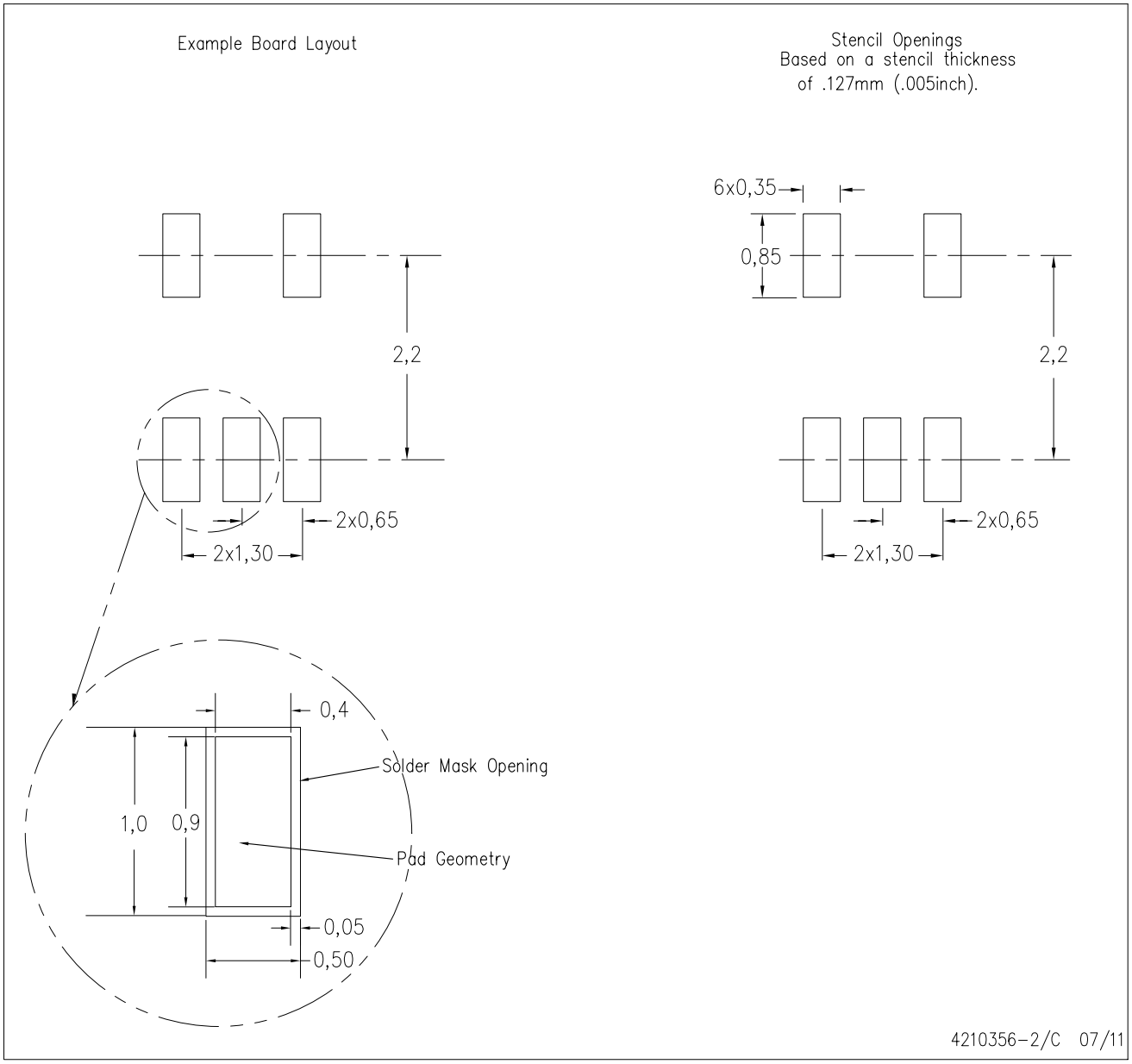
DCK (R–PDSO–G5) PLASTIC SMALL–OUTLINE PACKAGE



4093553–3/G 01/2007

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
D. Falls within JEDEC MO–203 variation AA.

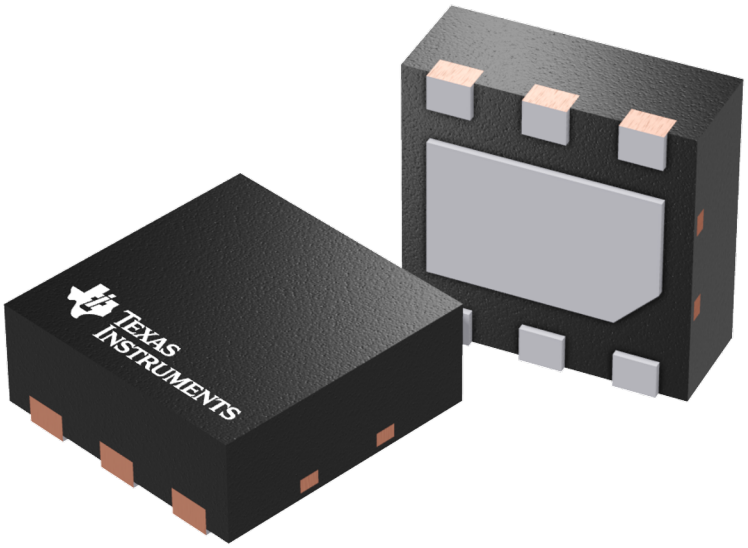
DCK (R–PDSO–G5) PLASTIC SMALL OUTLINE



NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
D. Publication IPC–7351 is recommended for alternate designs.
E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC–7525 for other stencil recommendations.

DRV 6 WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



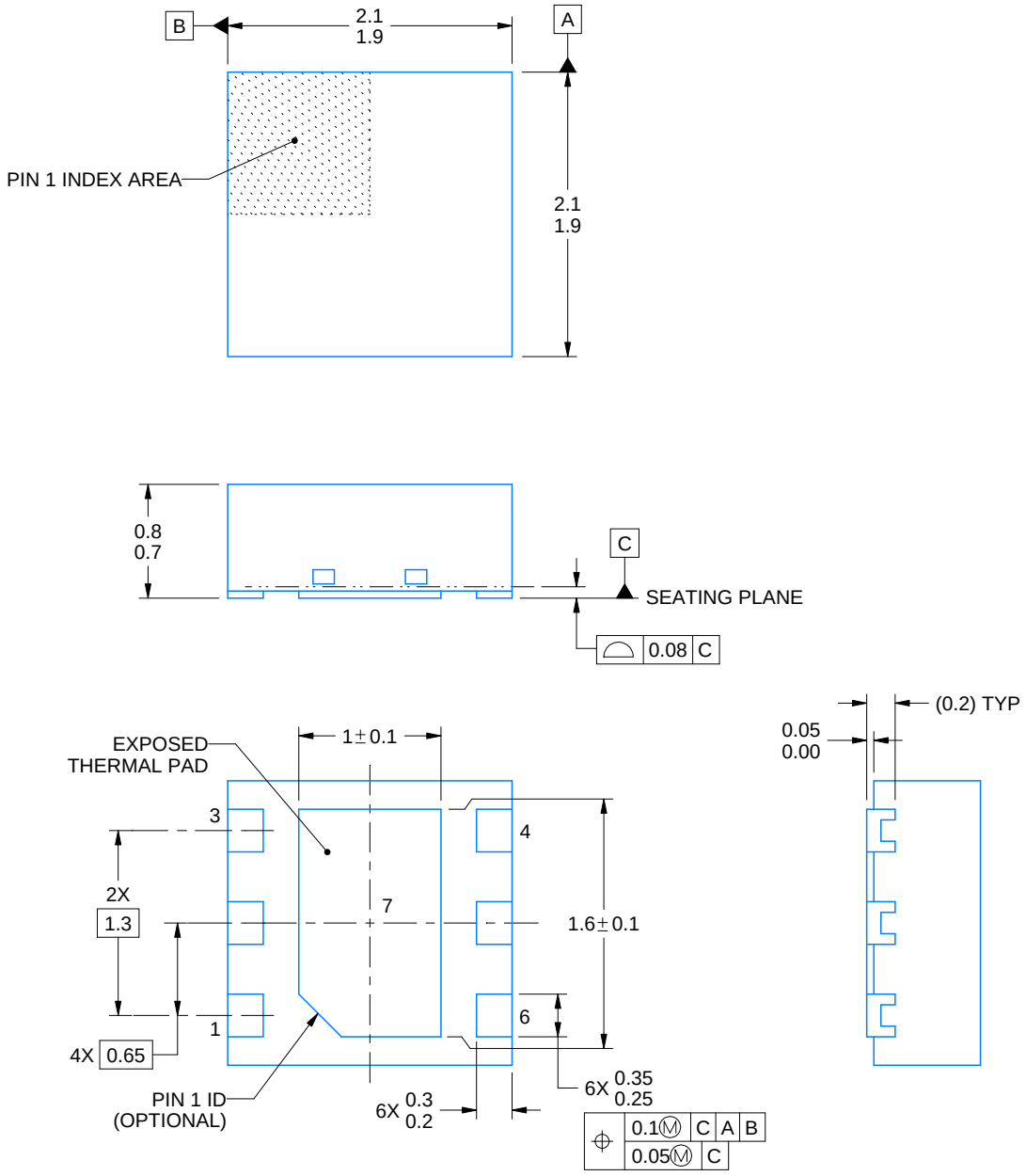
Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

DRV0006D

PACKAGE OUTLINE

WSON - 0.8 mm max height

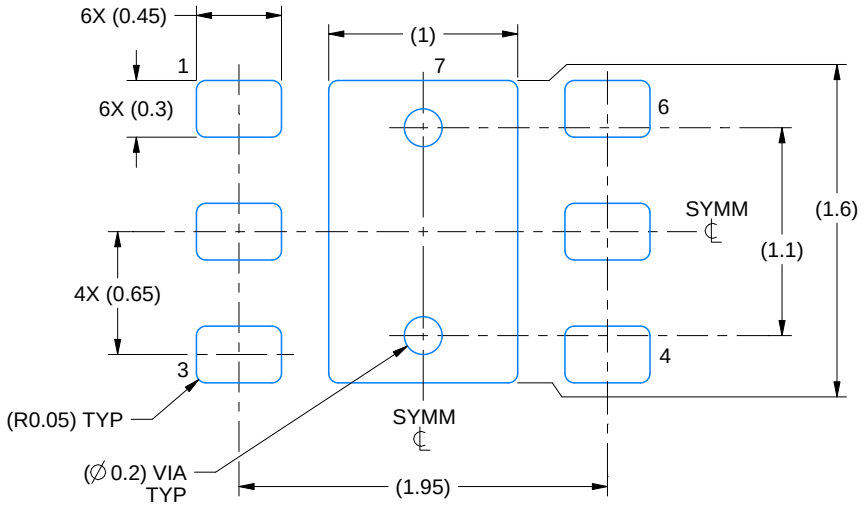
PLASTIC SMALL OUTLINE - NO LEAD



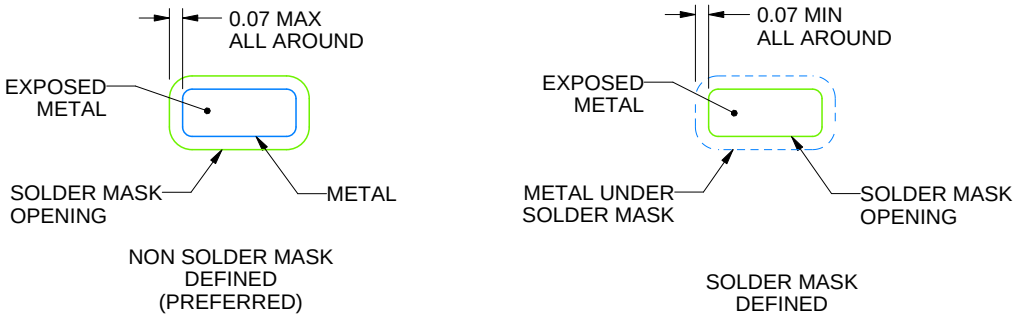
4225563/A 12/2019

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:25X

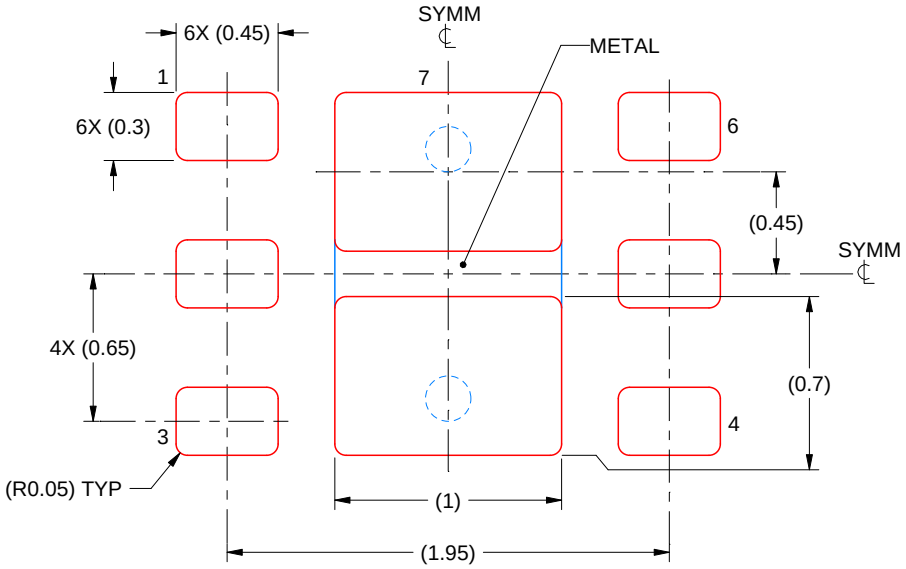


SOLDER MASK DETAILS

4225563/A 12/2019

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

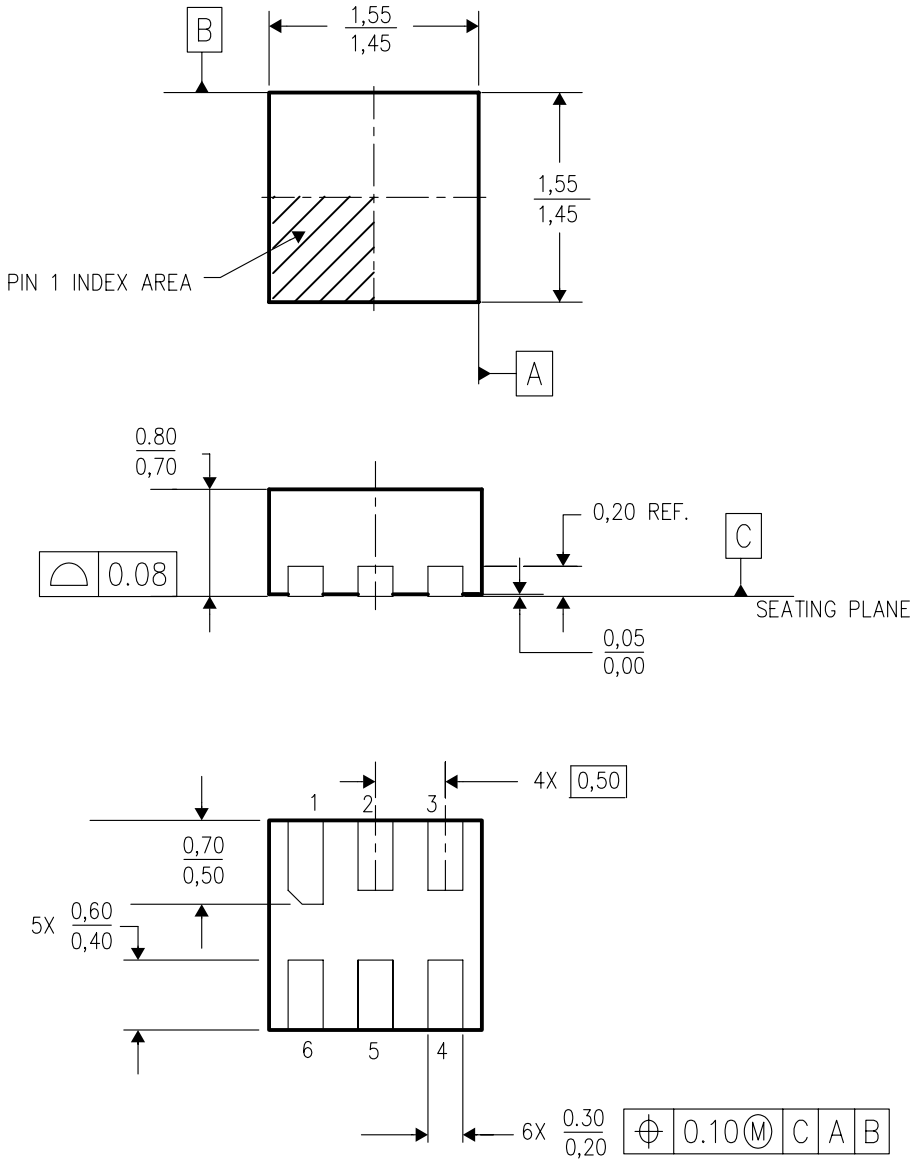
EXPOSED PAD #7
88% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:30X

4225563/A 12/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

DSE (S–PDSO–N6) PLASTIC SMALL OUTLINE



4207810/A 03/06

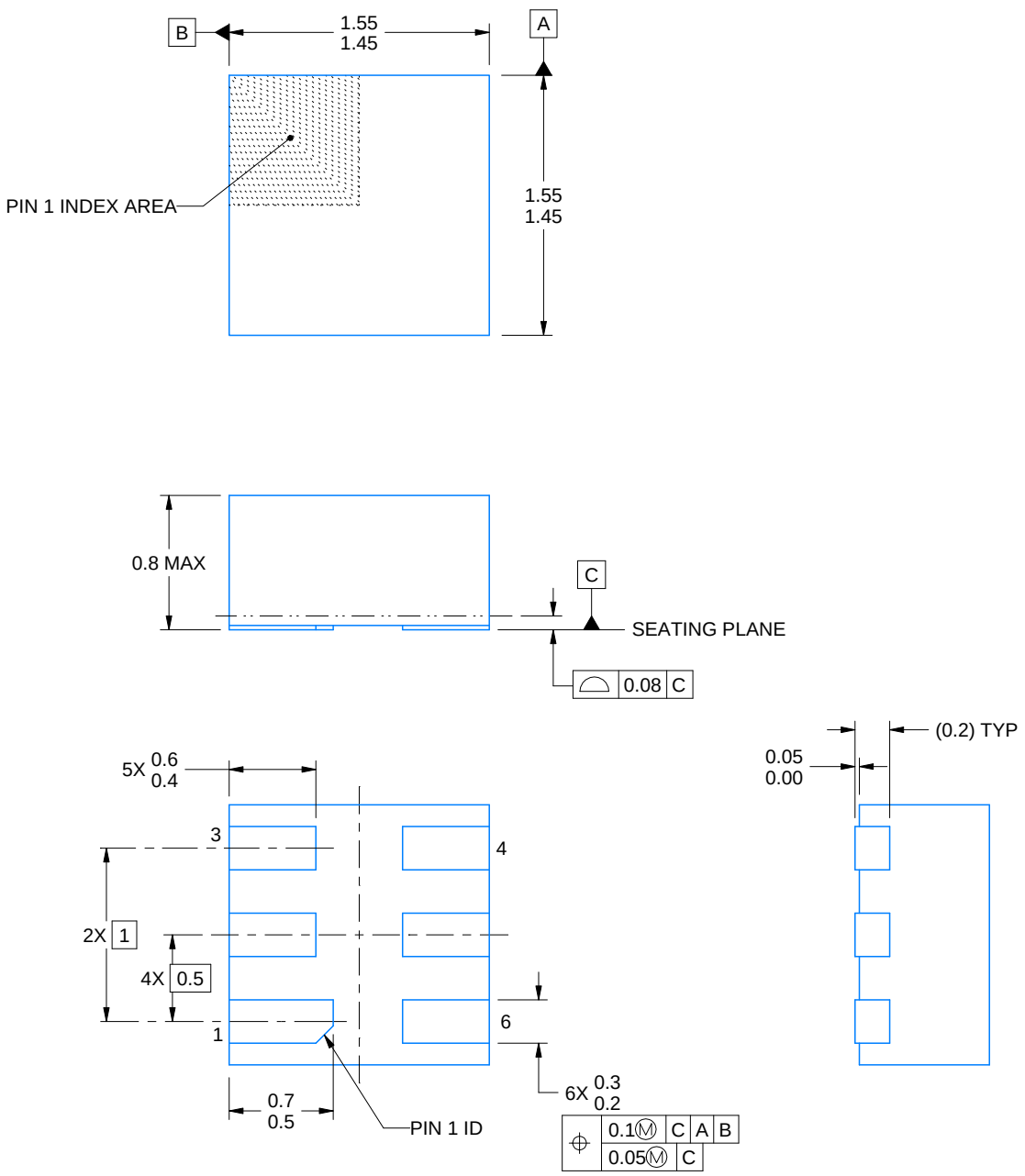
NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Small Outline No–Lead (SON) package configuration.
D. This package is lead–free.

DSE0006A

PACKAGE OUTLINE

WSON - 0.8 mm max height

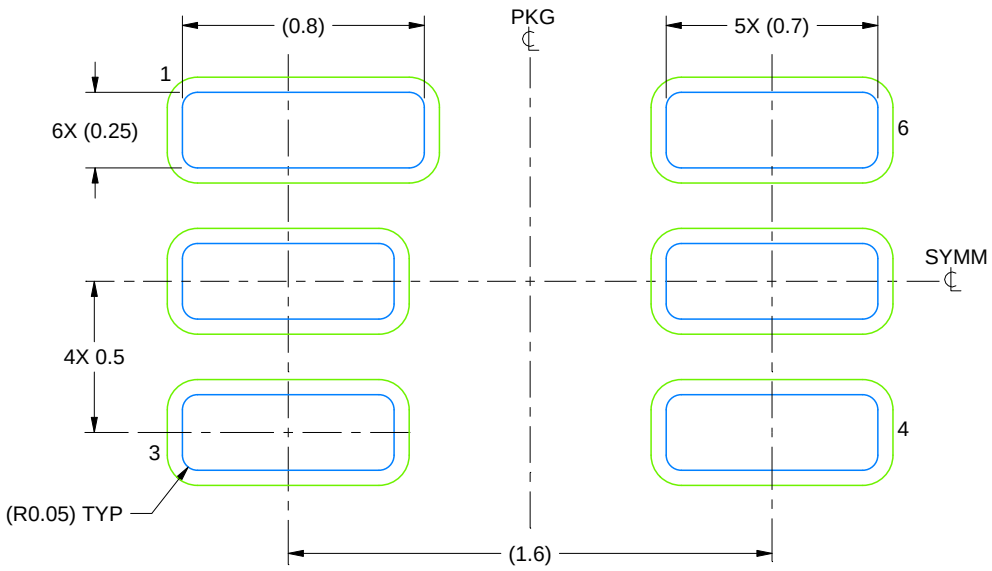
PLASTIC SMALL OUTLINE - NO LEAD



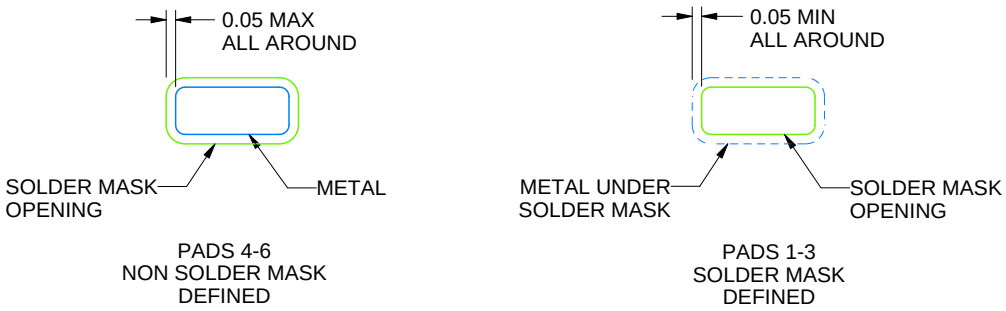
4220552/A 04/2021

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.



LAND PATTERN EXAMPLE
SCALE:40X

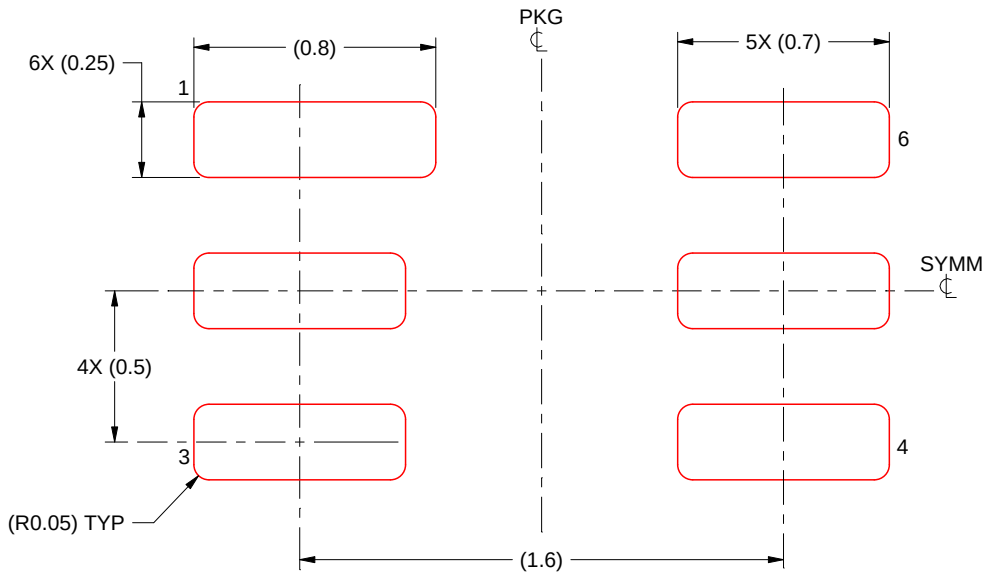


SOLDER MASK DETAILS

4220552/A 04/2021

NOTES: (continued)

3. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:40X

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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